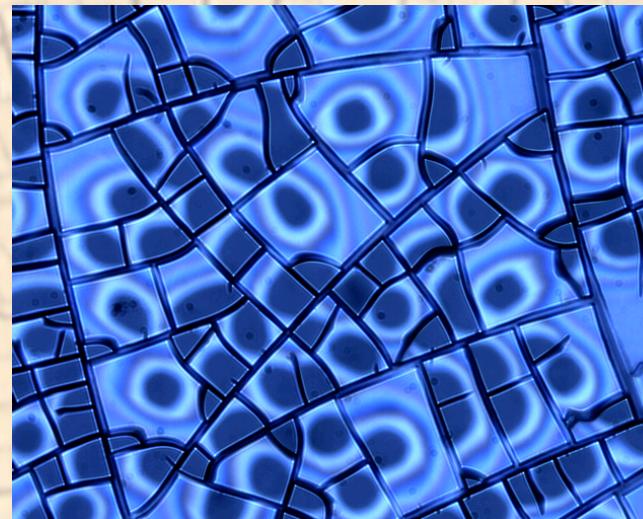


Drying of complex fluids: fractures

L. Pauchard

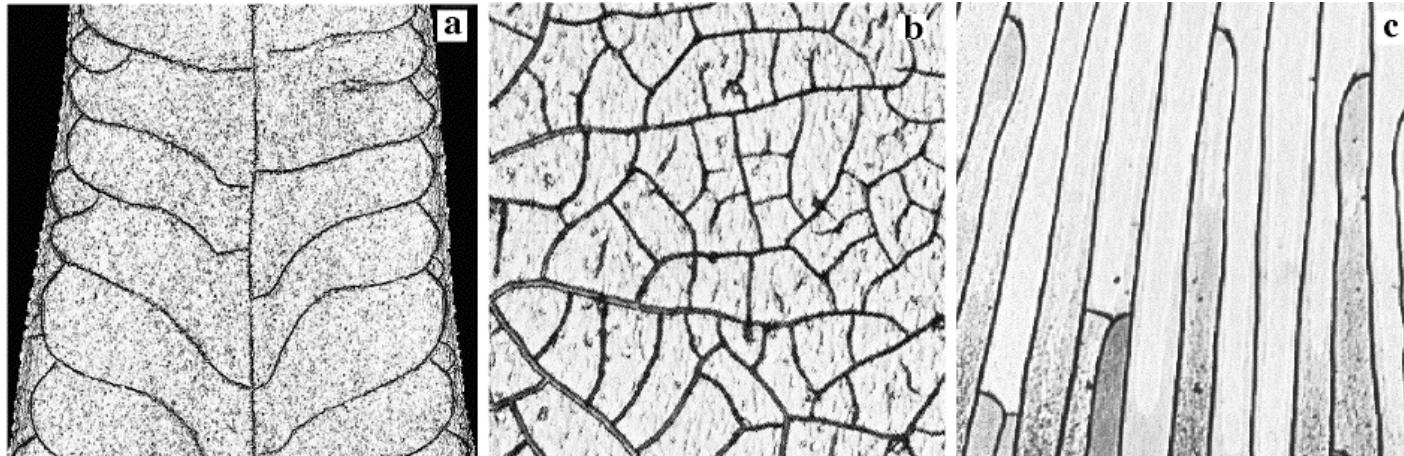
Fluides, Automatique, Systèmes Thermiques
Université d'Orsay, FRANCE



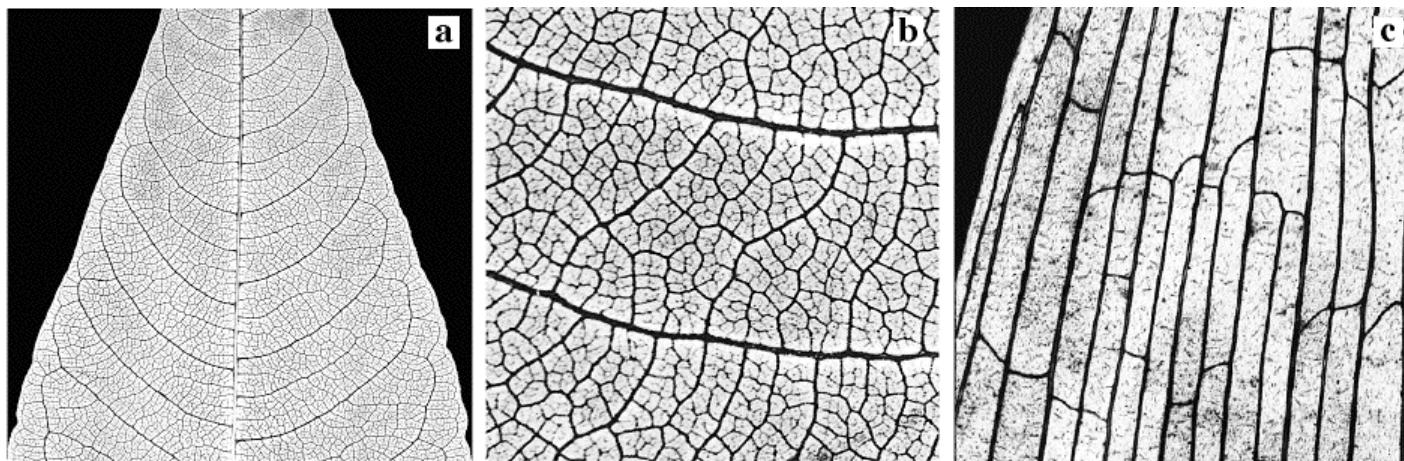
Some motivations...

- growth patterns

cracks



venation

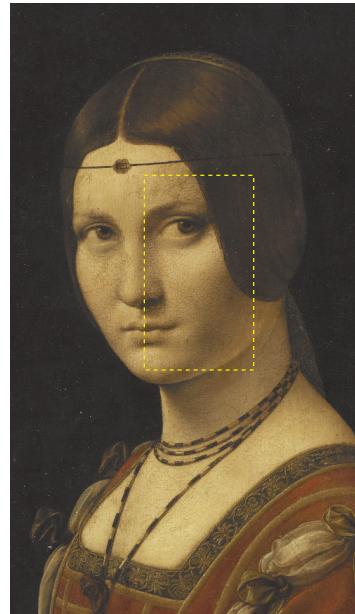


Interests to study crack patterns...

- restoration, judging authenticity and knowledge of techniques in Paintings

ANR « Morphologies » L. Pauchard, B. Abou, V. Lazarus, K. Sekimoto

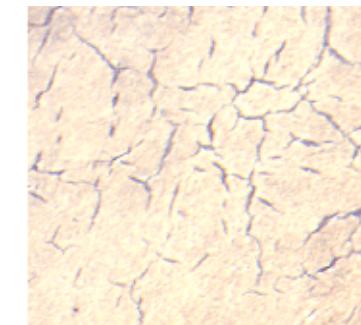
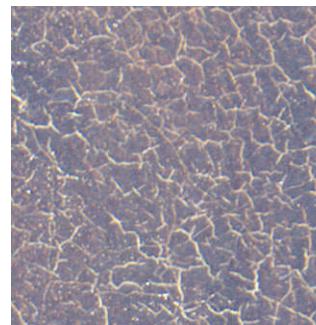
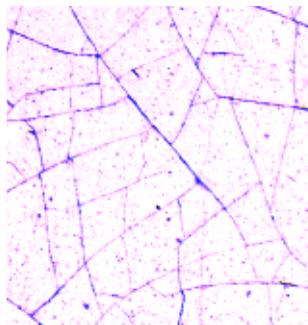
C. Lahanier, G. Aitken (Centre de Recherche et de Restauration des Musées de France - Musée du Louvre)



“la Belle Ferronnière”
De Vinci



large variety of craquelures



Interests to study crack patterns...

cracking due to a physical impact

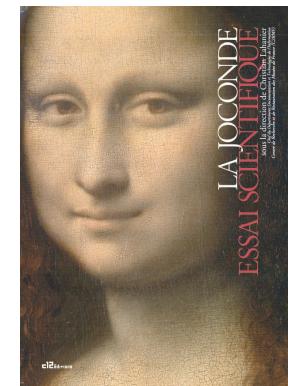
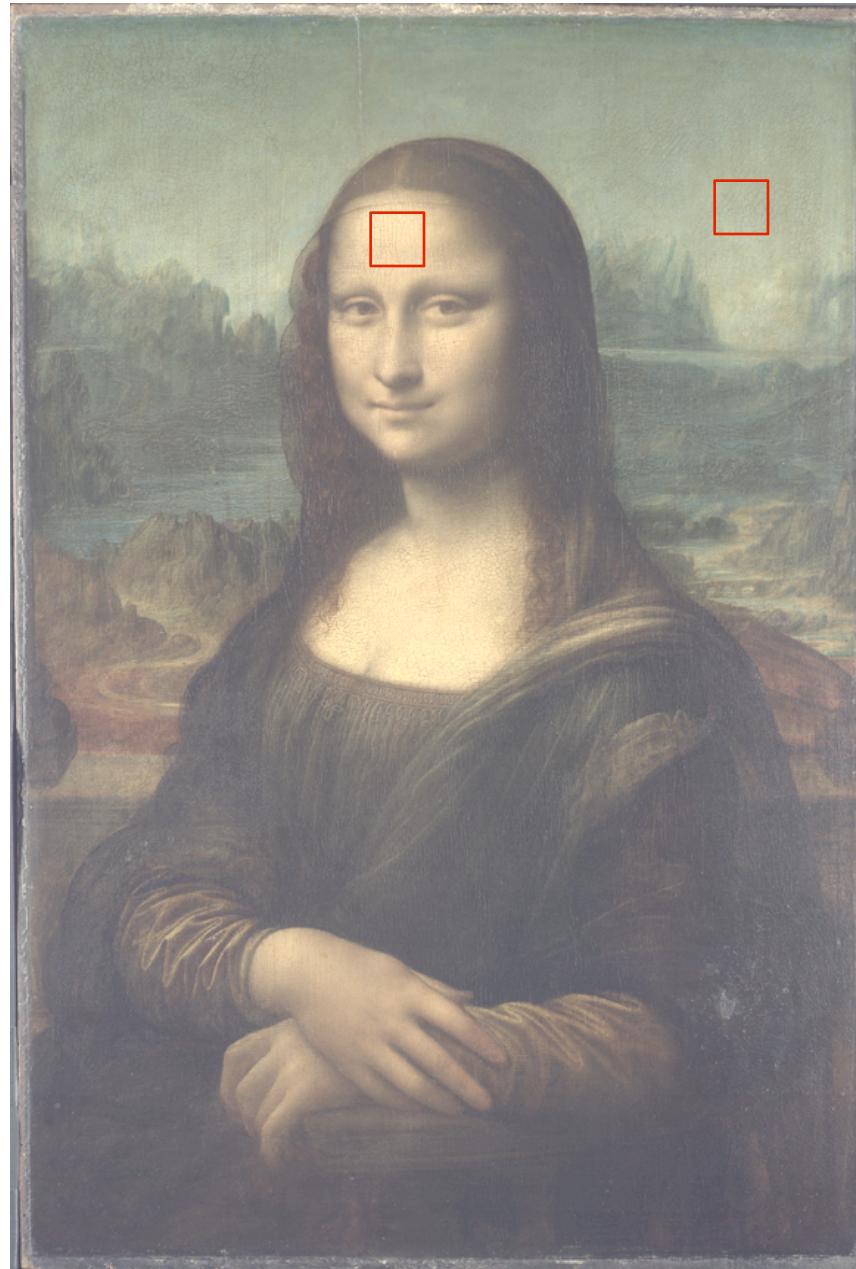


“Saint Matthias”
Georges de La Tour

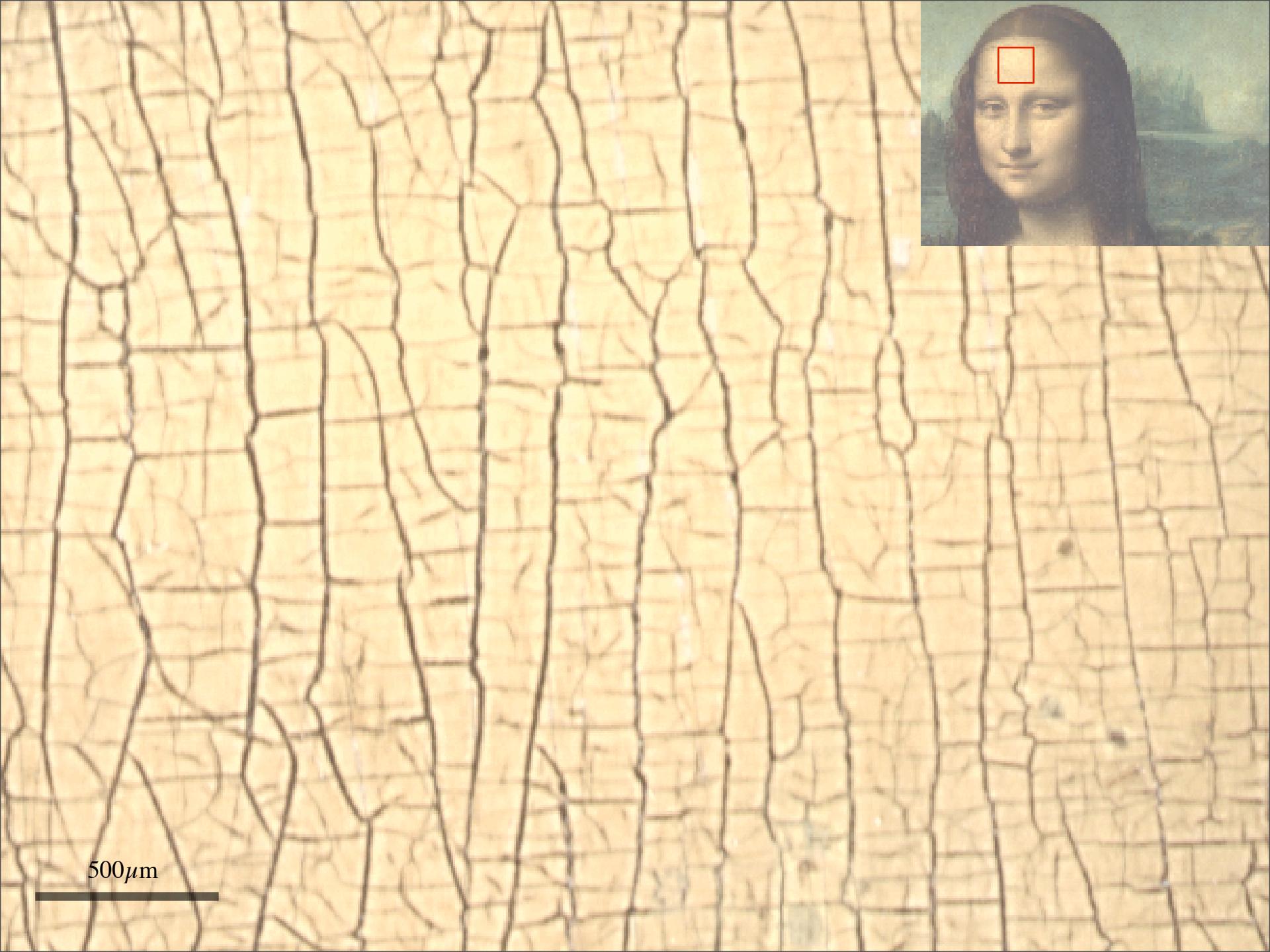
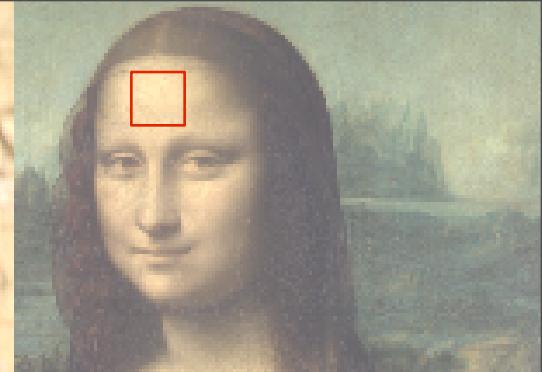


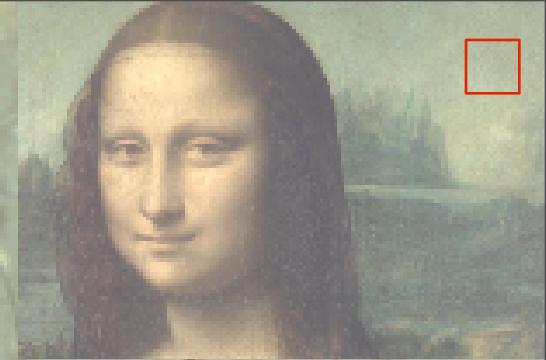
Exemple of craquelures linked to the support

la Joconde: Painting on a poplar panel



« la Joconde: essai scientifique
ouvrage collectif (2007)

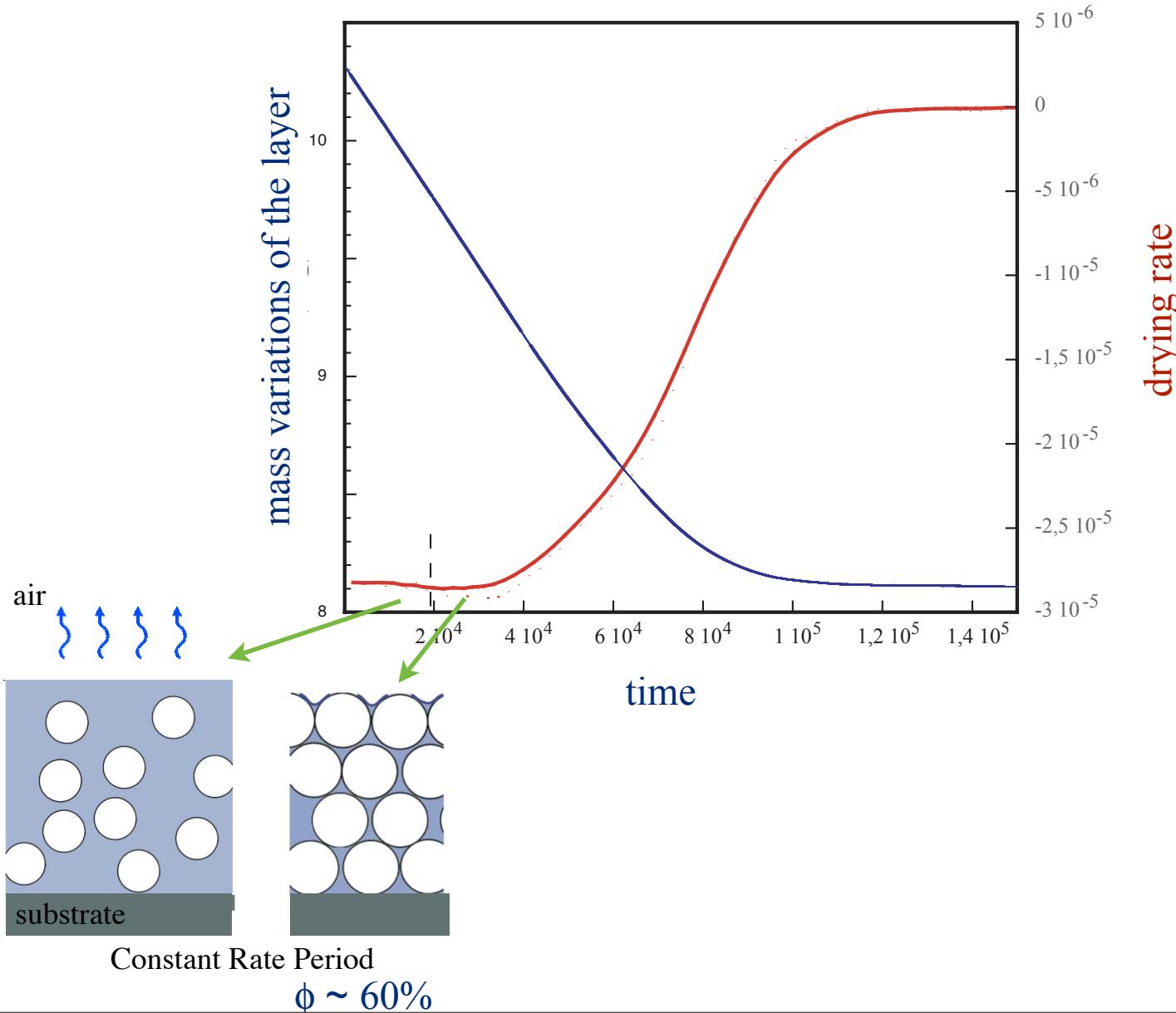




500 μ m

Model: drying colloidal suspensions

concentrated suspensions of colloidal particles (nanolatex $\phi \sim 15\text{nm}$, $\phi_{V0} \sim 30\%$)

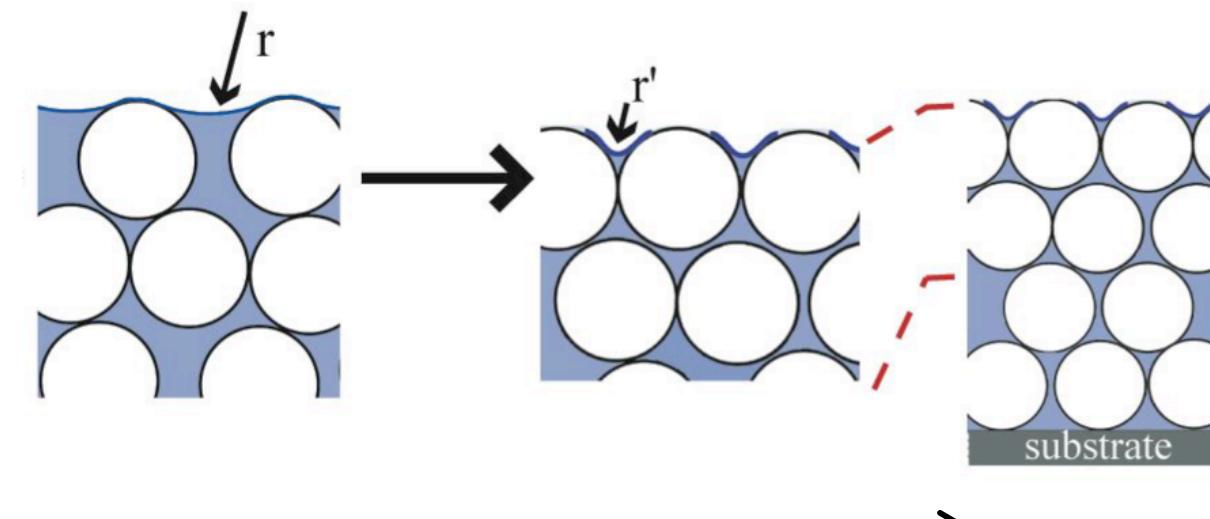


Drying colloidal suspensions

Mechanical stress induced by desiccation

evaporation \Rightarrow high capillary pressure

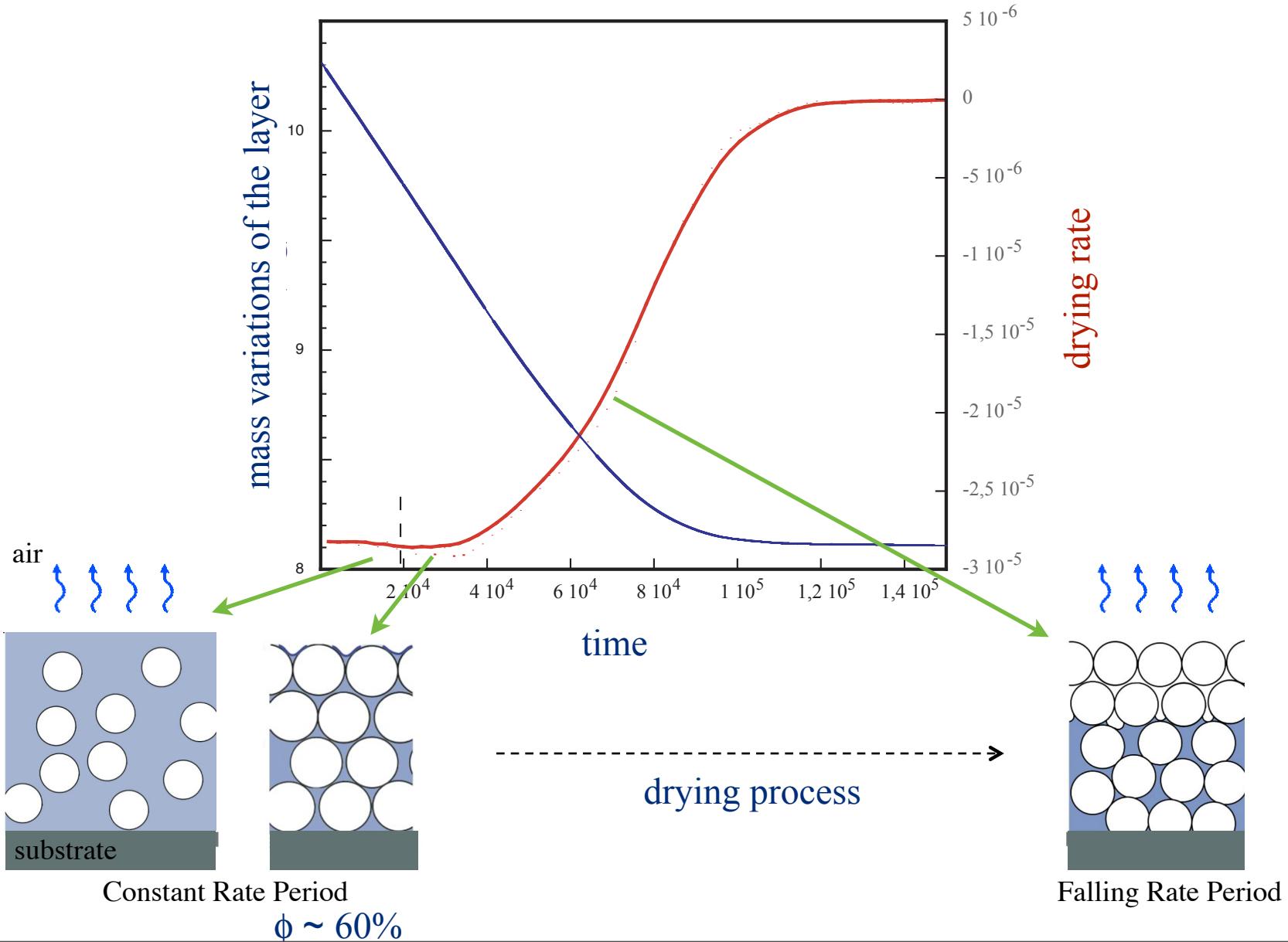
$$P = -2 \frac{\gamma_{\text{solvent/air}} \cdot \cos\theta}{r_{\text{pore}}} \sim -10^7 \text{ Pa}$$



shrinkage limited by adhesion

Model: drying colloidal suspensions

concentrated suspensions of colloidal particles ($\phi_{V0} \sim 30\%$)



Drying colloidal suspensions

Mechanical stress induced by desiccation

Drying stress due to:

- * shrinkage induced by capillary pressure limited by adhesion
- * shrinkage-resistance by the compressibility modulus of the gel

mechanical stress → elastic energy stored in the consolidating layer

Drying colloidal suspensions

Mechanical stress induced by desiccation

flux balance at the drying surface: $\dot{V}_E = \frac{D}{\eta} \nabla P |_{surface}$ Darcy'law

$$D \propto (\text{porosity}) \times (\text{pore radius})^2$$

drying stress depends on transport parameters: $\sigma \sim \frac{\eta h \dot{V}_E}{D}$

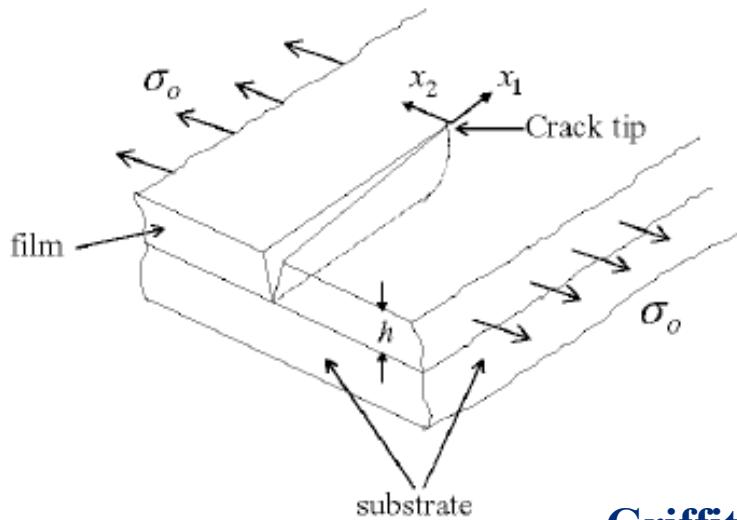
mechanical stress depend on:

- * permeability of porous matrix
- * elasticity of porous matrix
- * drying kinetics
- * presence of surfactants (diminishing capillary pressure)

Drying colloidal suspensions

Mechanical stress induced by desiccation

mechanical stress $\sigma_{ij} \rightarrow$ elastic energy stored in the consolidating layer



Griffith criterion

recovery of elastic energy

$$\Delta E = h \iint \left\{ \sigma_{33} d\varepsilon'_{33} + \sigma_{22} d\varepsilon'_{22} + 2\sigma_{23} d\varepsilon'_{23} \right\} dx_2$$

||

cost of surface energy

||

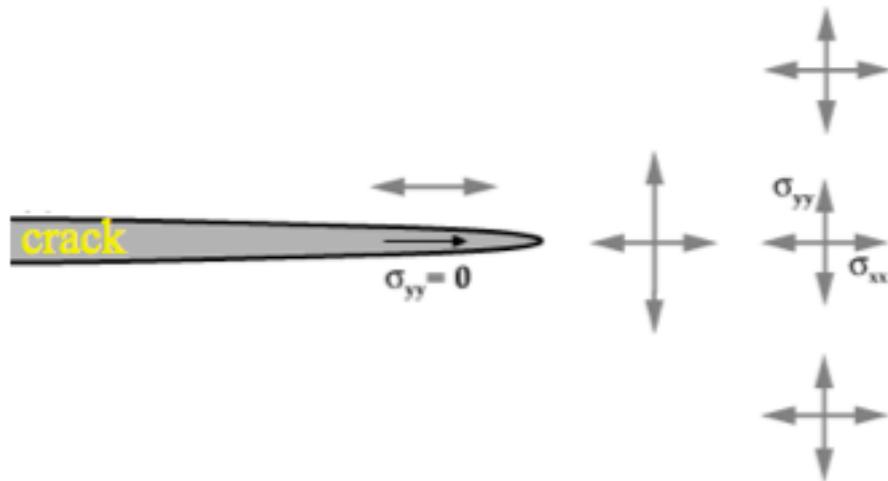
$$2h\gamma$$

Griffith *Trans. R. Soc. London* (1920)

Xia, Hutchinson *J. Mech. Phys. Solids* (2000)

Drying colloidal suspensions

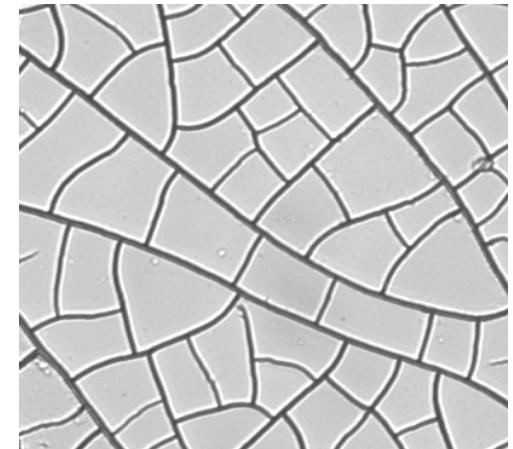
Mechanical stress induced by desiccation



QUIZ #1

What is the angles distribution in a cracks pattern ?

in the plane ?



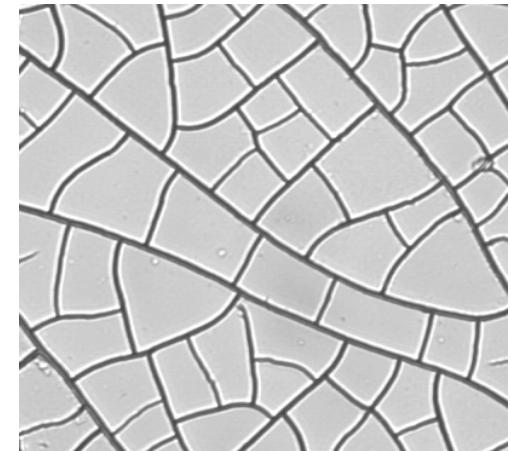
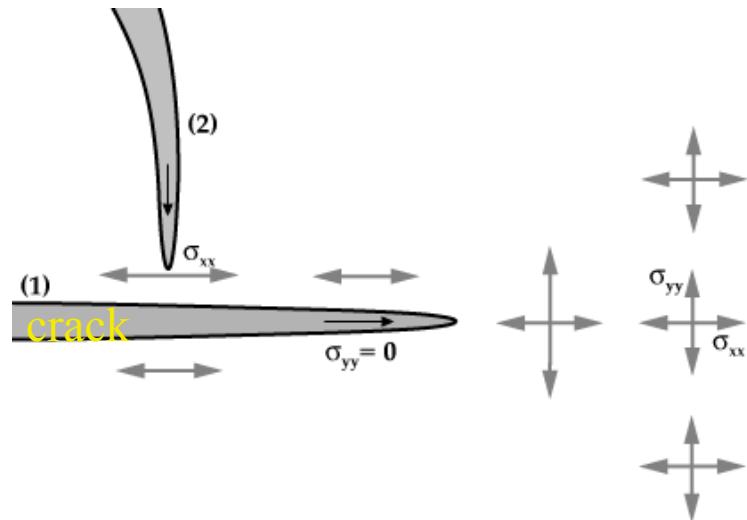
in 3D ?

QUIZ #1

What is the angles distribution in a cracks pattern ?

in the plane ?

- 90° due to connection between cracks



- 120° due to nucleation process in certain conditions

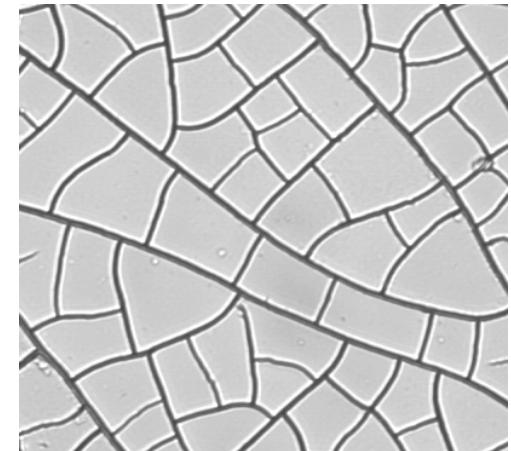
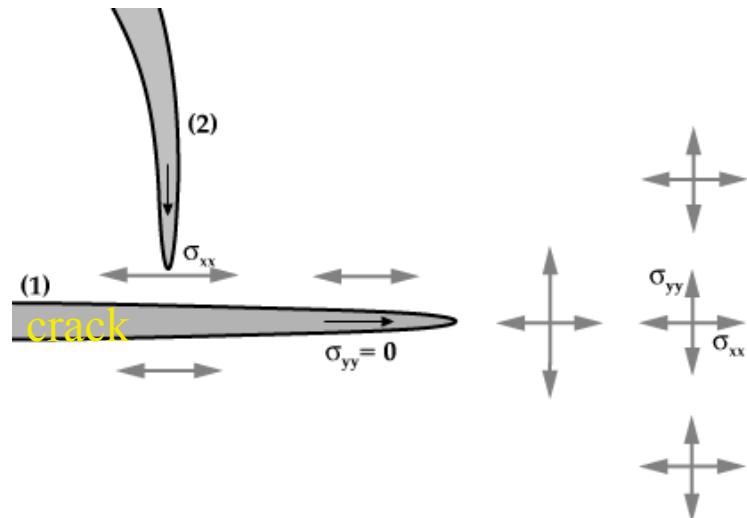
in 3D ?

QUIZ #1

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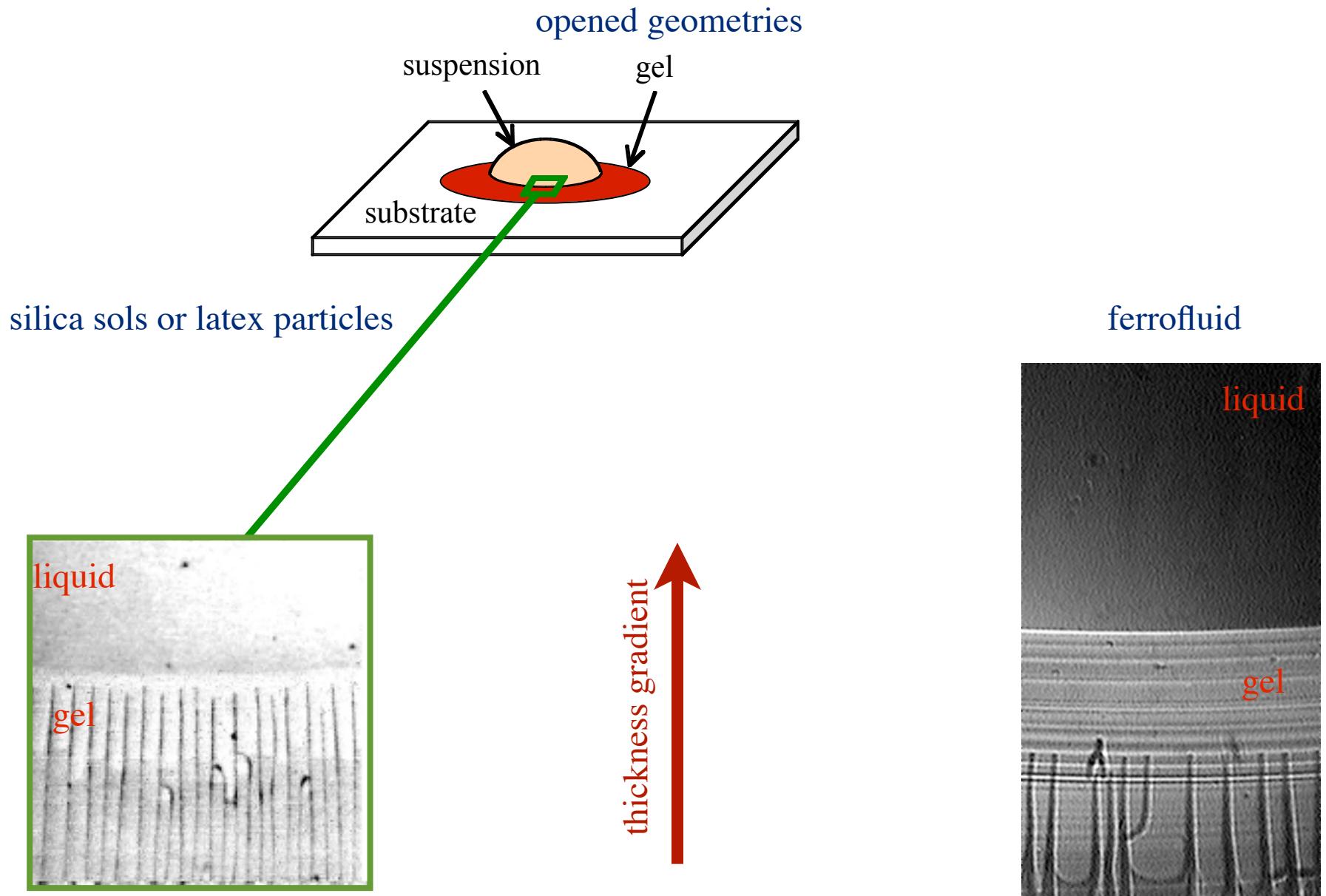
- 120° due to nucleation process in certain conditions

in 3D ?

more complex: depends on the growth kinetics

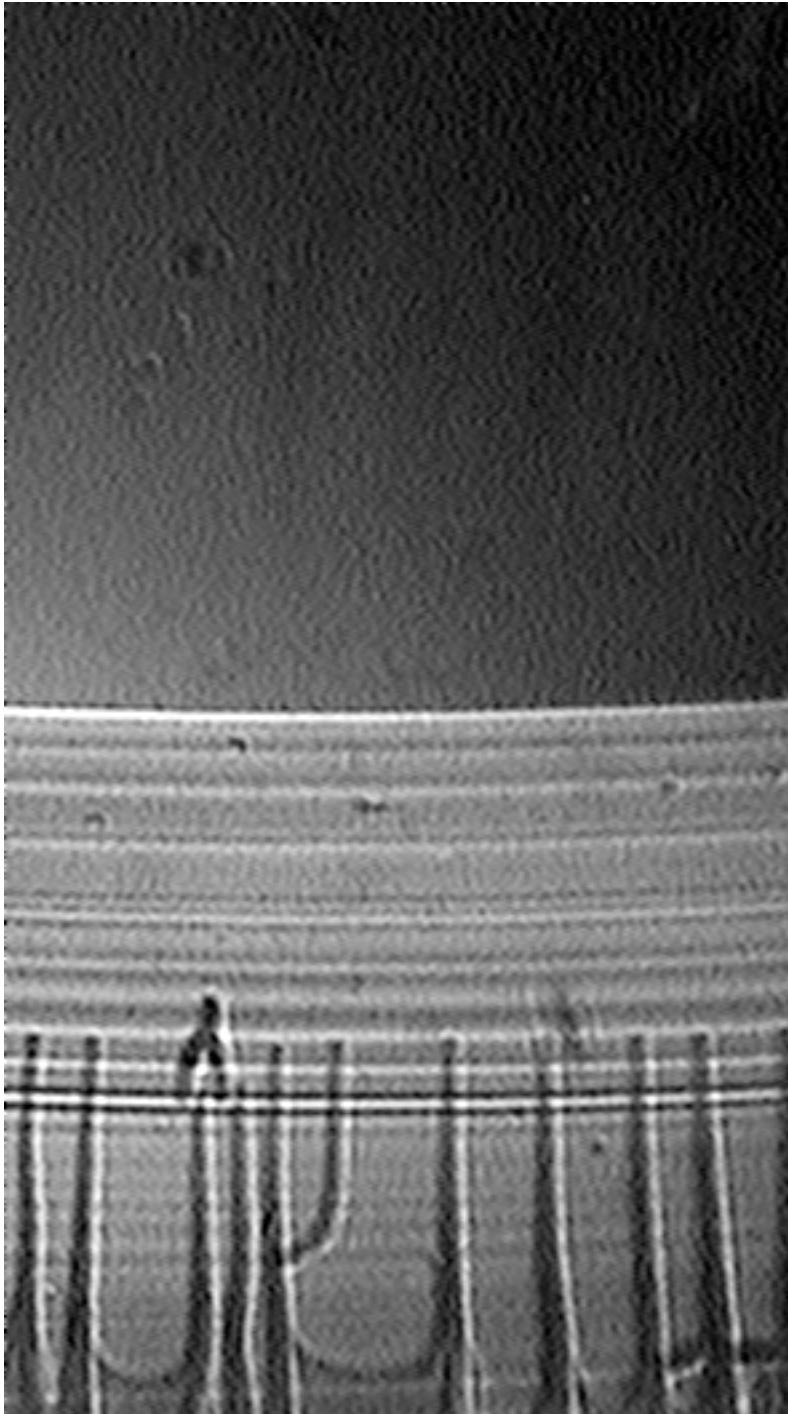


Directional propagation of cracks



II. fractures
directional

magnetic
colloidal particles

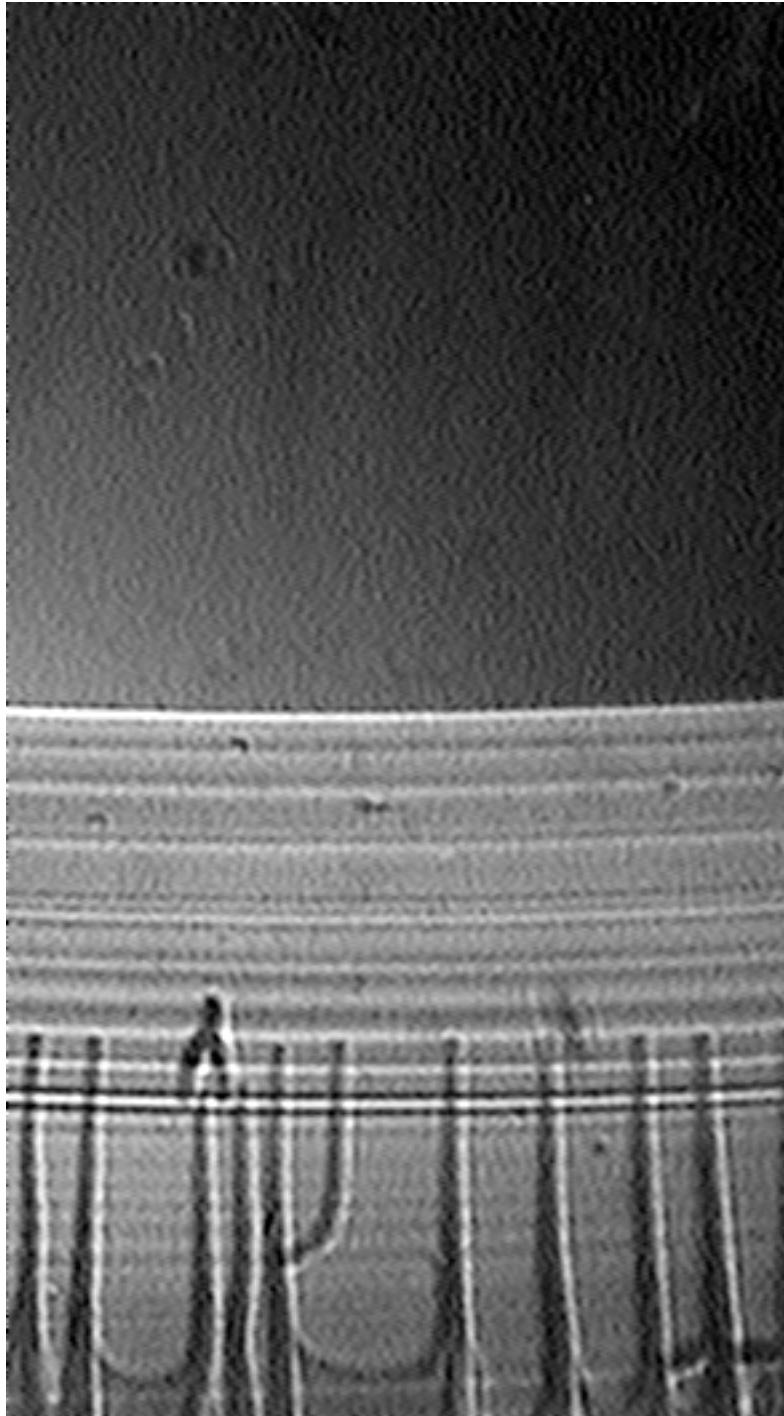


liquid

gel

magnetic
colloidal particles

\vec{B}
→
 \vec{B}
→
 \vec{B}
→
 \vec{B}
→
 \vec{B}
→



liquid

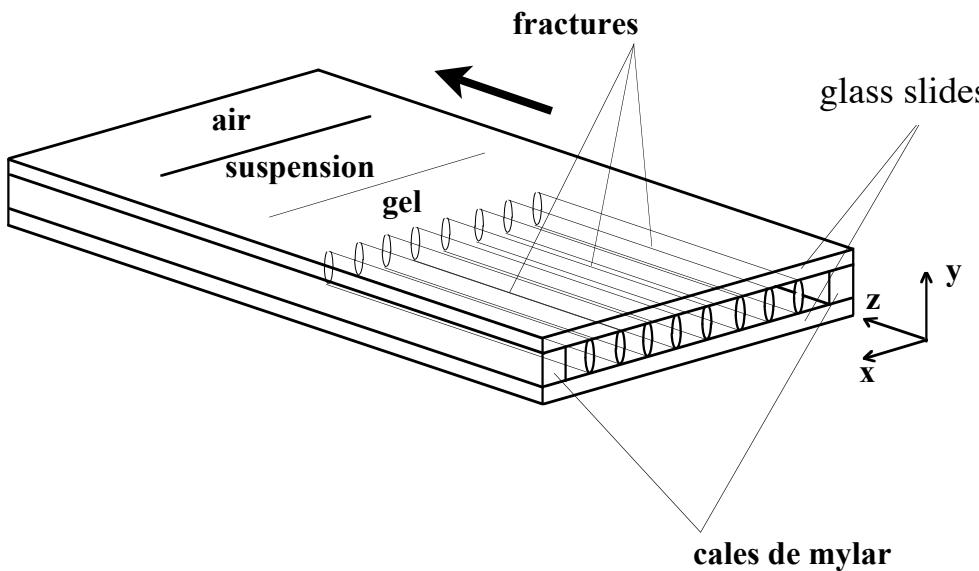
gel

Directional propagation of cracks

confined geometries

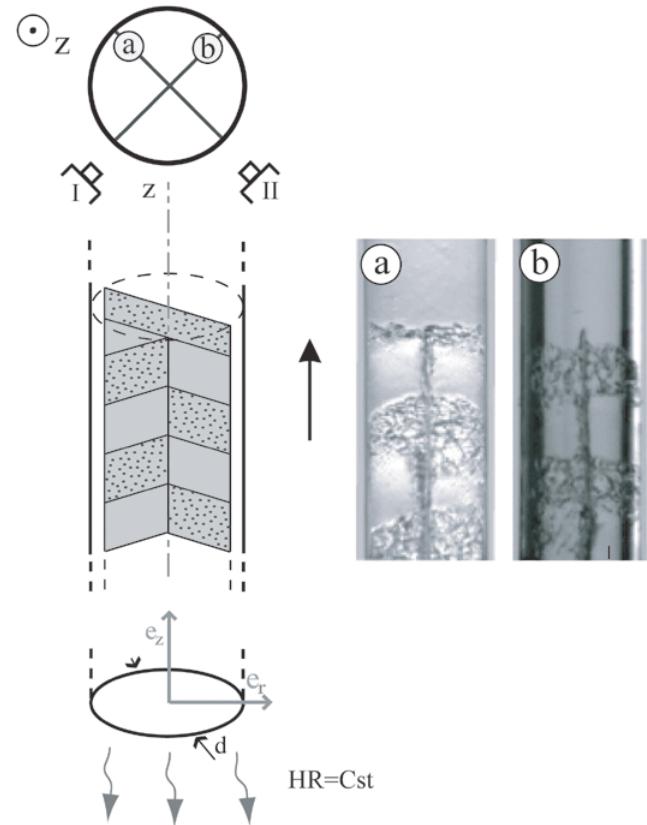
II. fractures
directional

Hele Shaw cell



Allain, Limat *Phys. Rev. Lett.* (1995)
Dufresne et al. *Phys. Rev. Lett.* (2003)

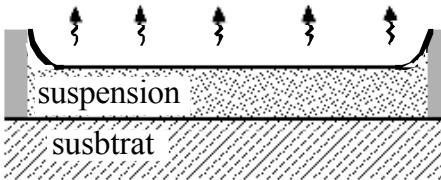
capillary tube



Gauthier et al. *Langmuir* (2007)



Isotropic crack patterns



final patterns for layers of different thicknesses

crack free

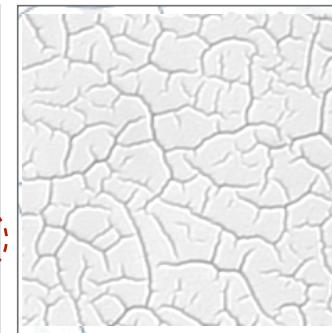
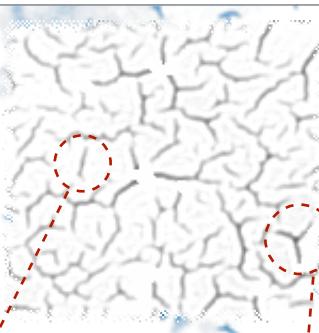
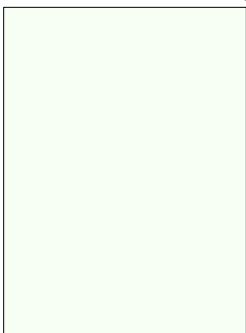
isolated junctions

sinuous paths

connected networks

h_c

$10^{-7} \text{ m} < h_c < 10^{-6} \text{ m}$



8

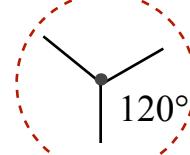
12

$h_f (\mu\text{m})$

15

15 μm

30 μm

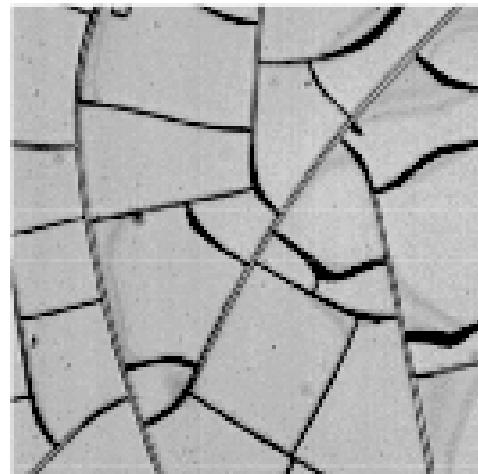
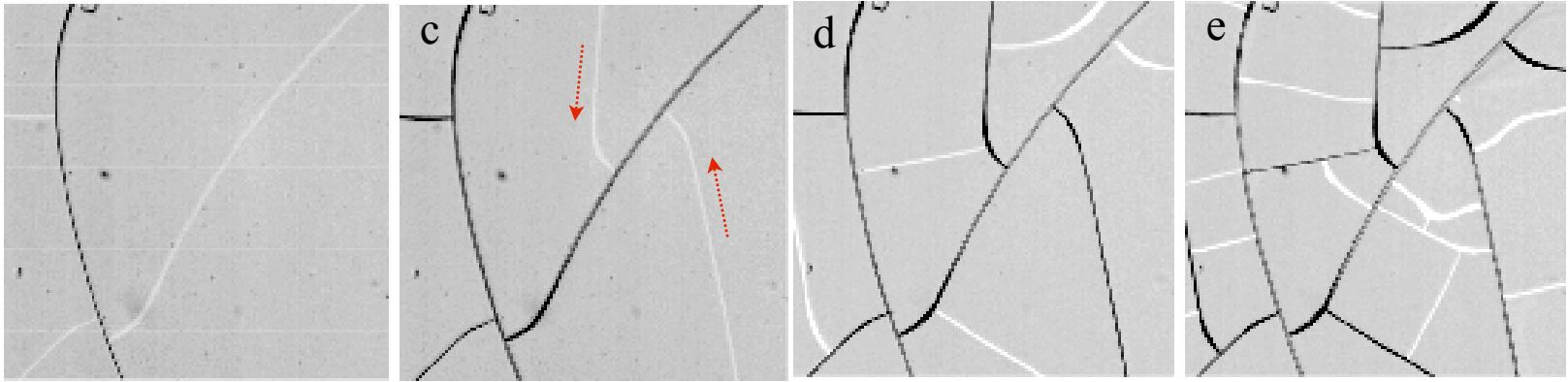


$$\text{surface area: } A_{cell} = f \left(\begin{array}{c} \text{porous matrix elasticity} \\ \text{adhesion} \\ \text{drying rate} \end{array} \right) \cdot h_f^2$$

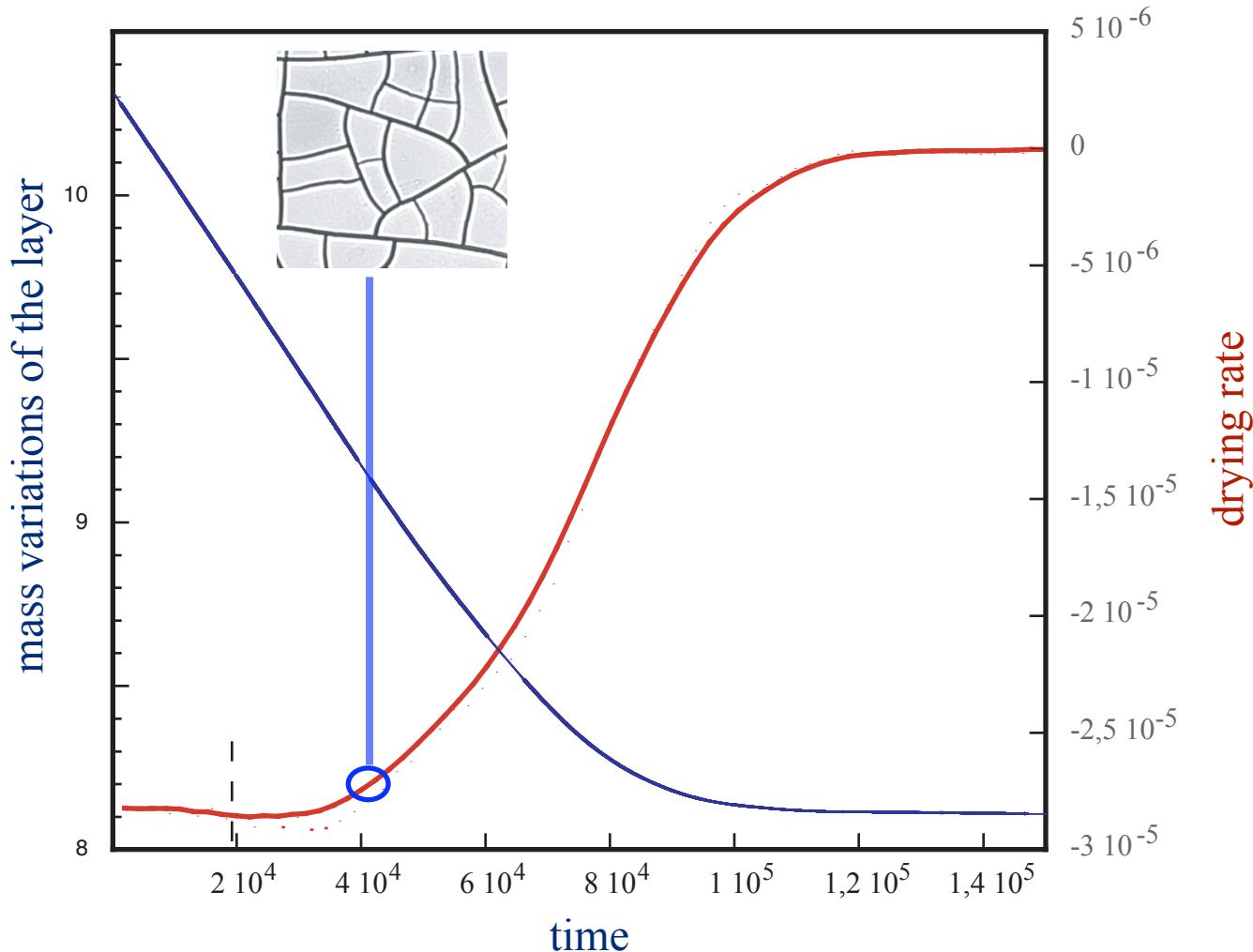
Hierarchical formation of cracks network

II. fractures
isotropic

consolidation



Drying kinetics

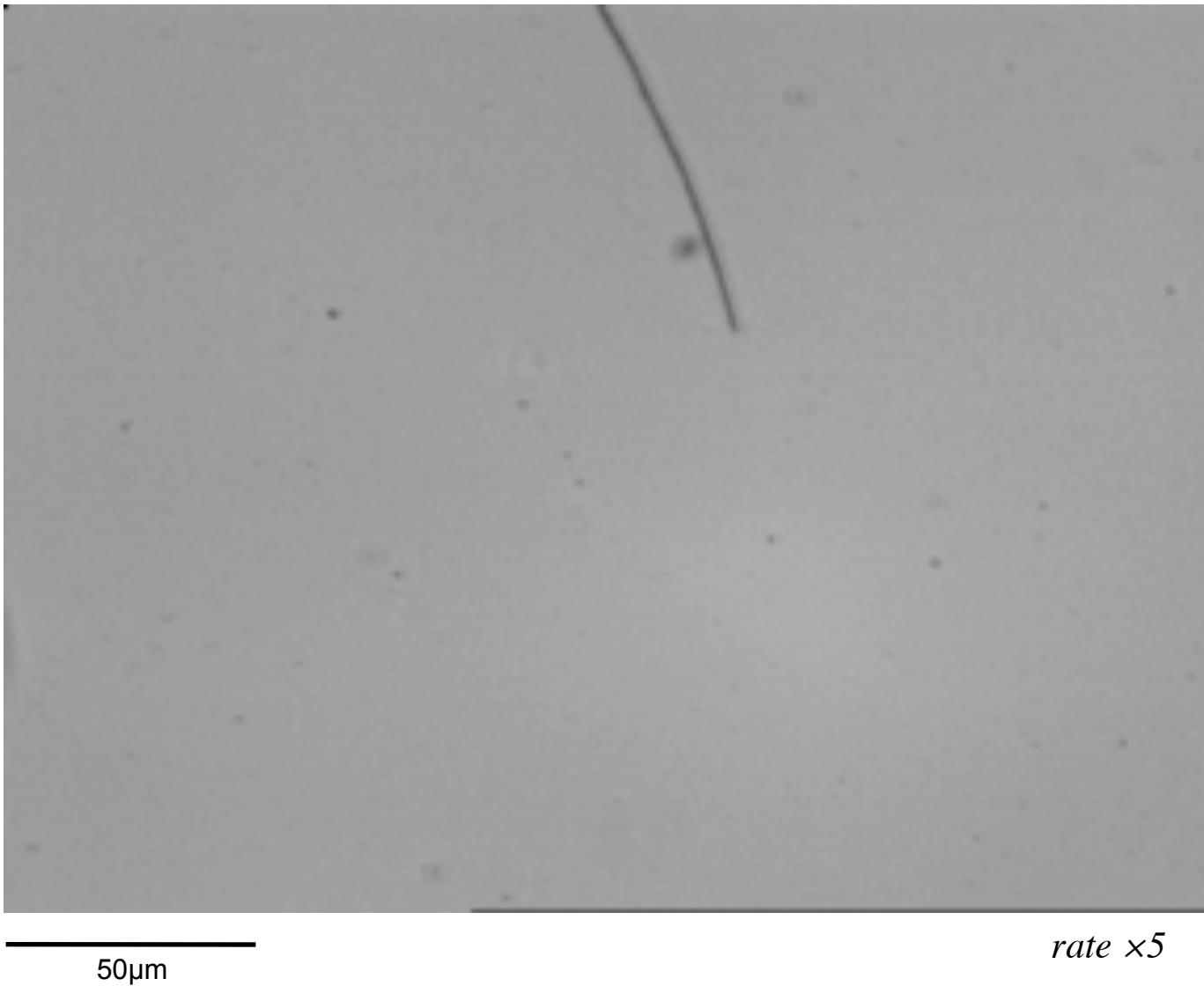


Delamination process

50µm

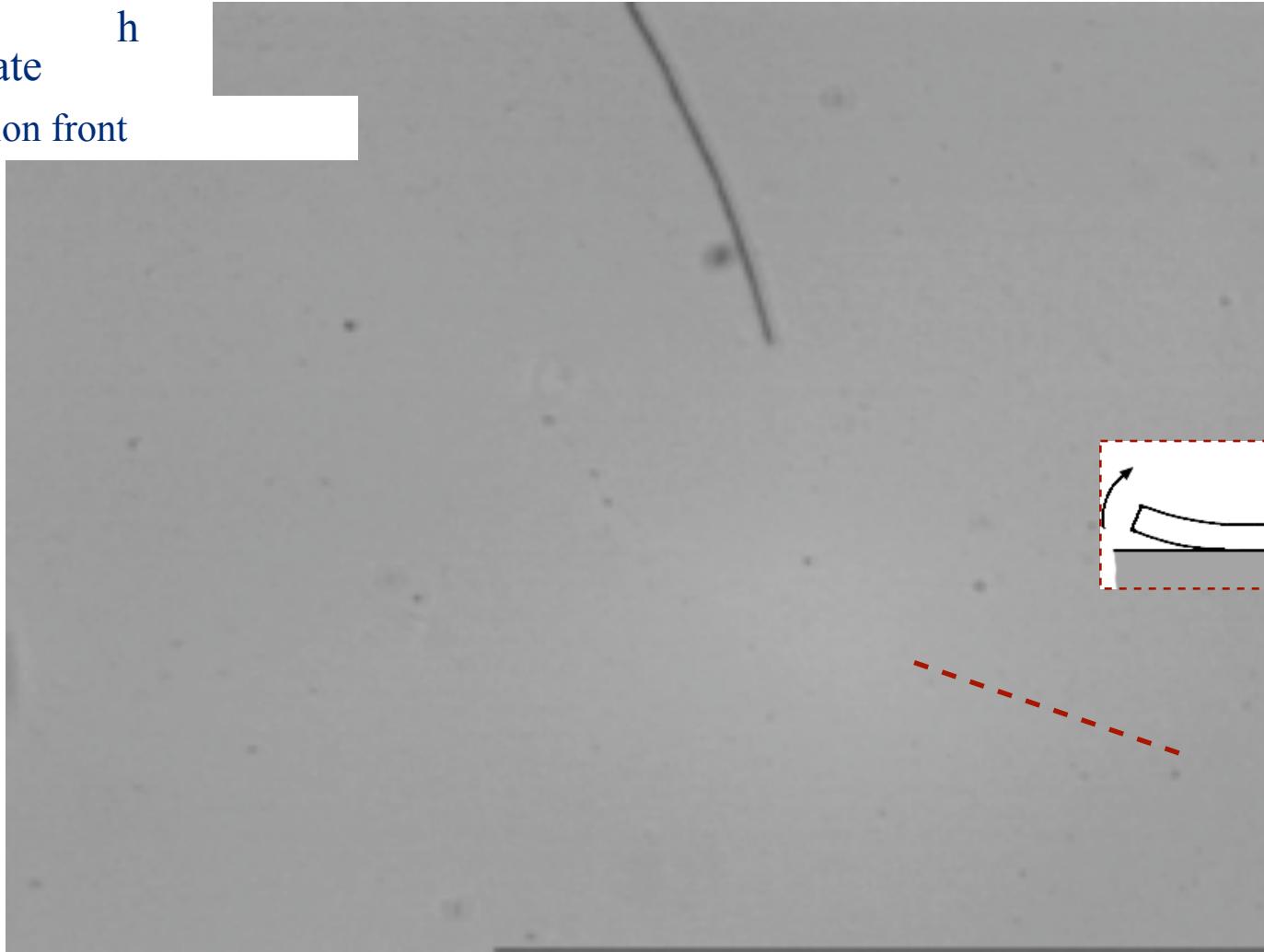
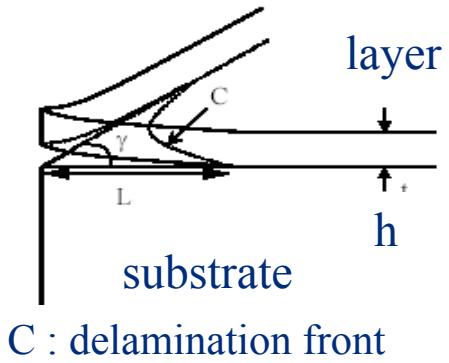
rate ×5

Delamination process



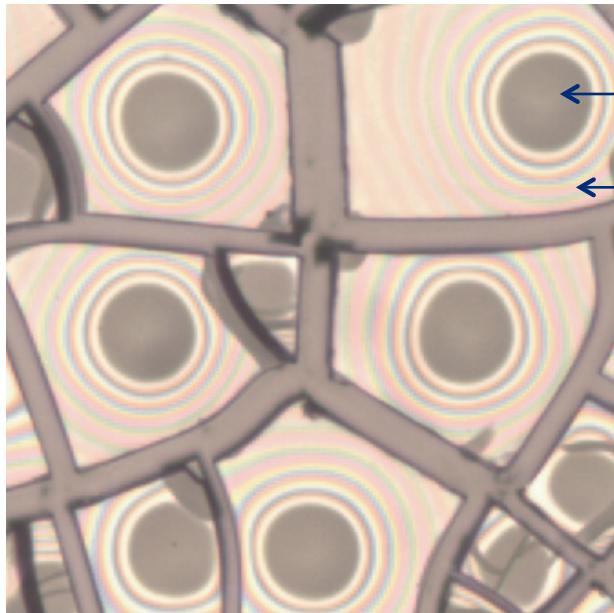
II. fractures
isotropic

Delamination process



rate $\times 5$

Delamination process



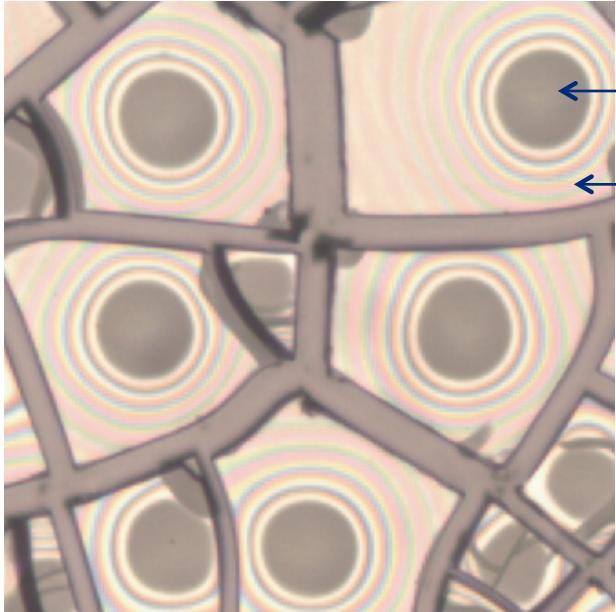
A_{adh}
 A_{cell}

measuring A_{adh}/A_{cell}
↓
adhesion energy gel/substrate

?



Delamination process



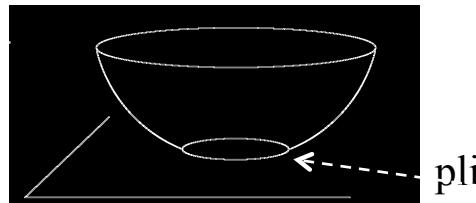
A_{adh}
 A_{cell}

measuring A_{adh}/A_{cell}
adhesion energy gel/substrate

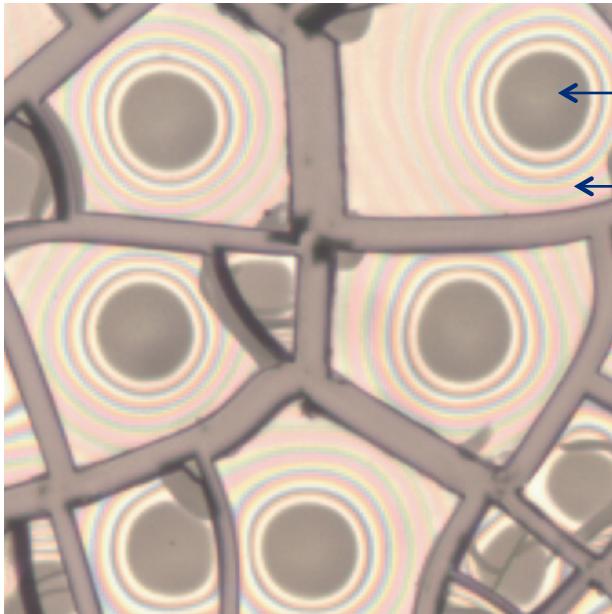
?



Competition between elastic energy : $\frac{h_f}{R} \ll 1$ $U_{buckl} = \frac{2C}{3[12(1-\nu^2)]^{3/4}} Y \left(\frac{h_f}{R} \right)^{5/2} r^3$



Delamination process



A_{adh}

A_{cell}

measuring A_{adh}/A_{cell}

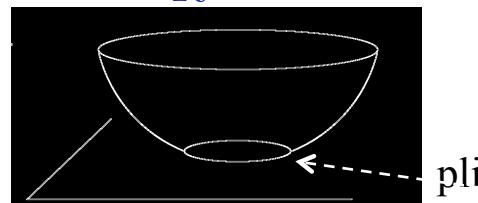
adhesion energy gel/substrate

?



Competition between elastic energy : $\frac{h_f}{R} \ll 1$

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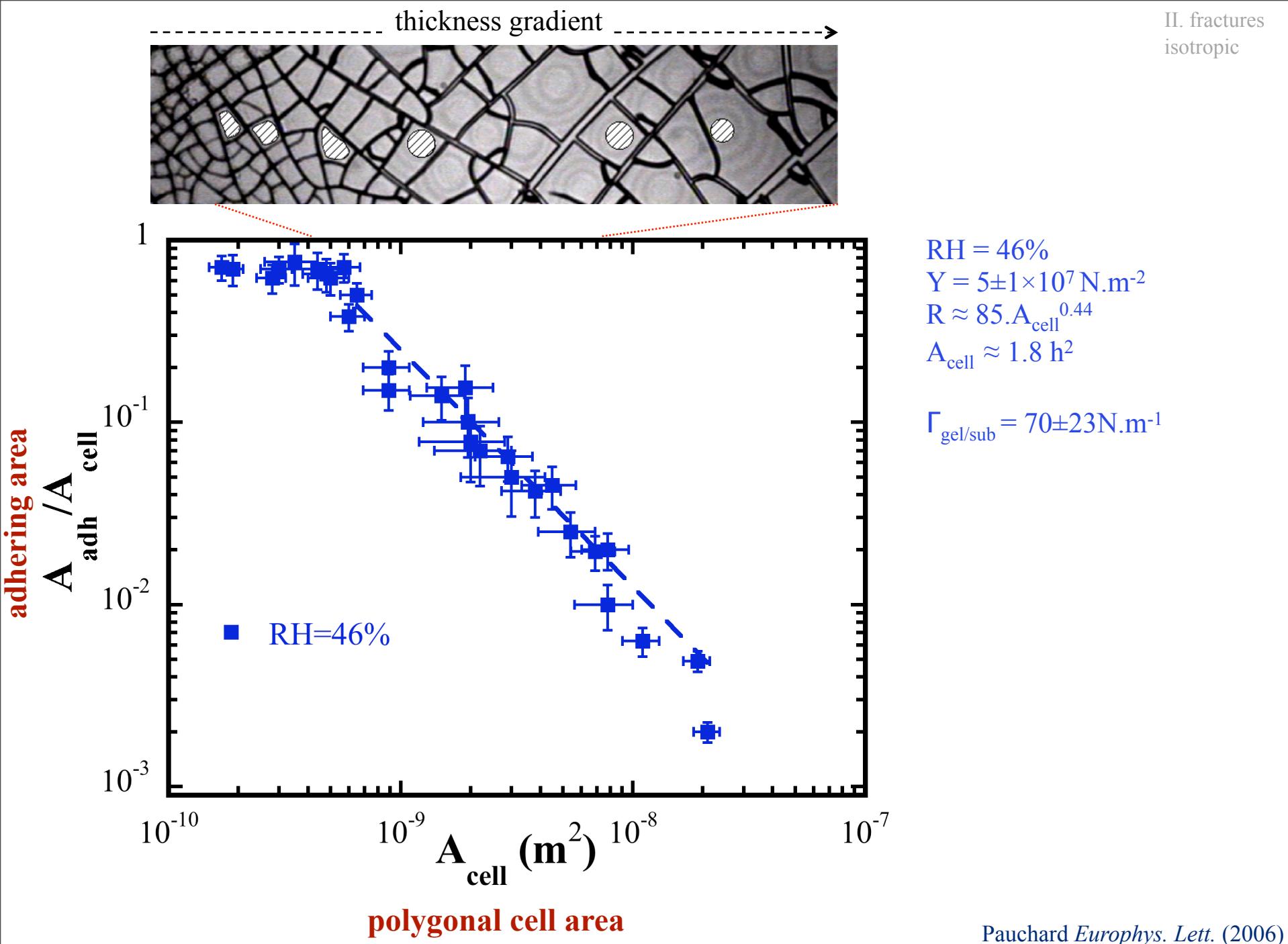


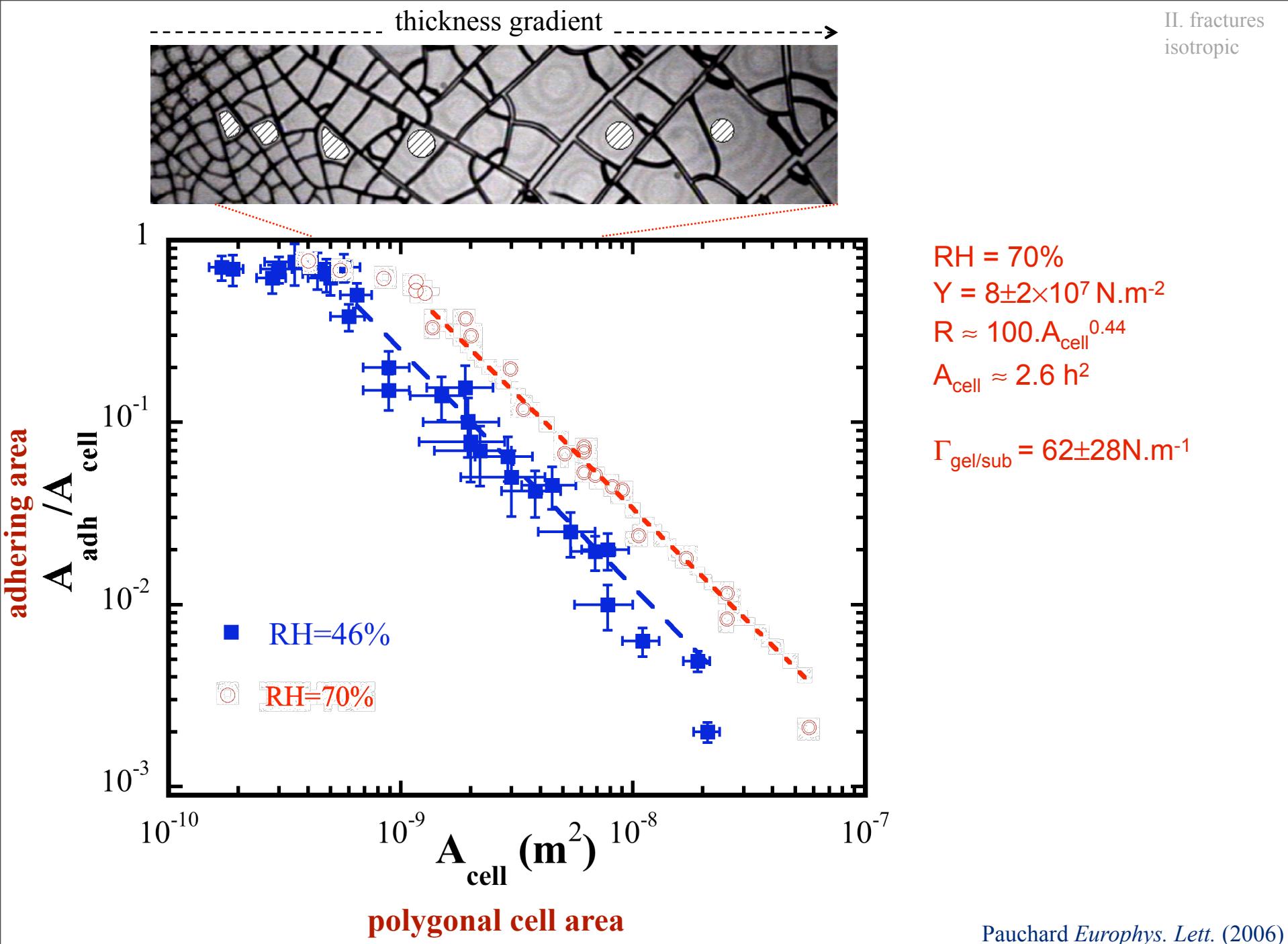
and interfacial crack energy :

$$U_{crack} = 2\Gamma_{gel/substrat} (A_{cell} - A_{adh})$$



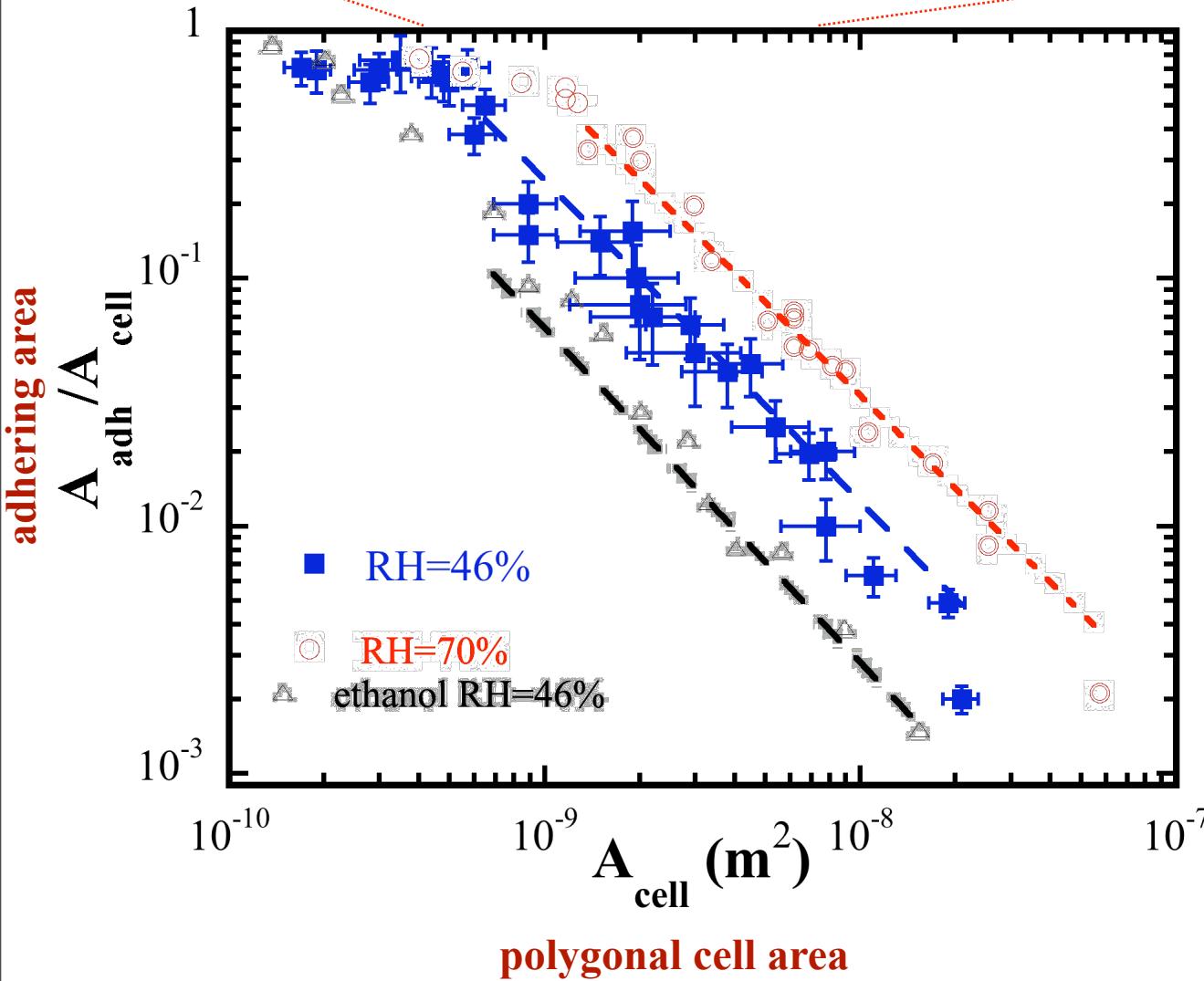
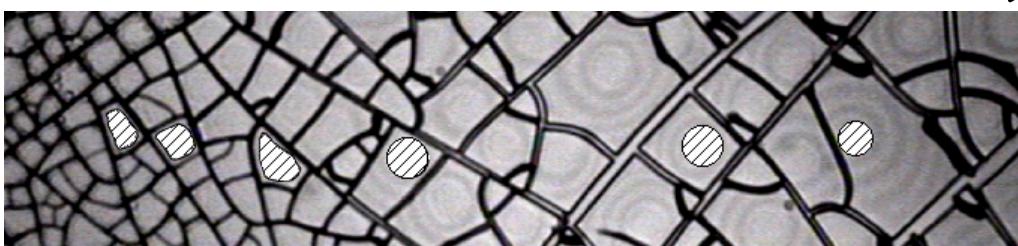
$$\Gamma_{gel/substrat} \propto Y A_{adh}^{1/2} \left(\frac{h_f}{R} \right)^{5/2}$$



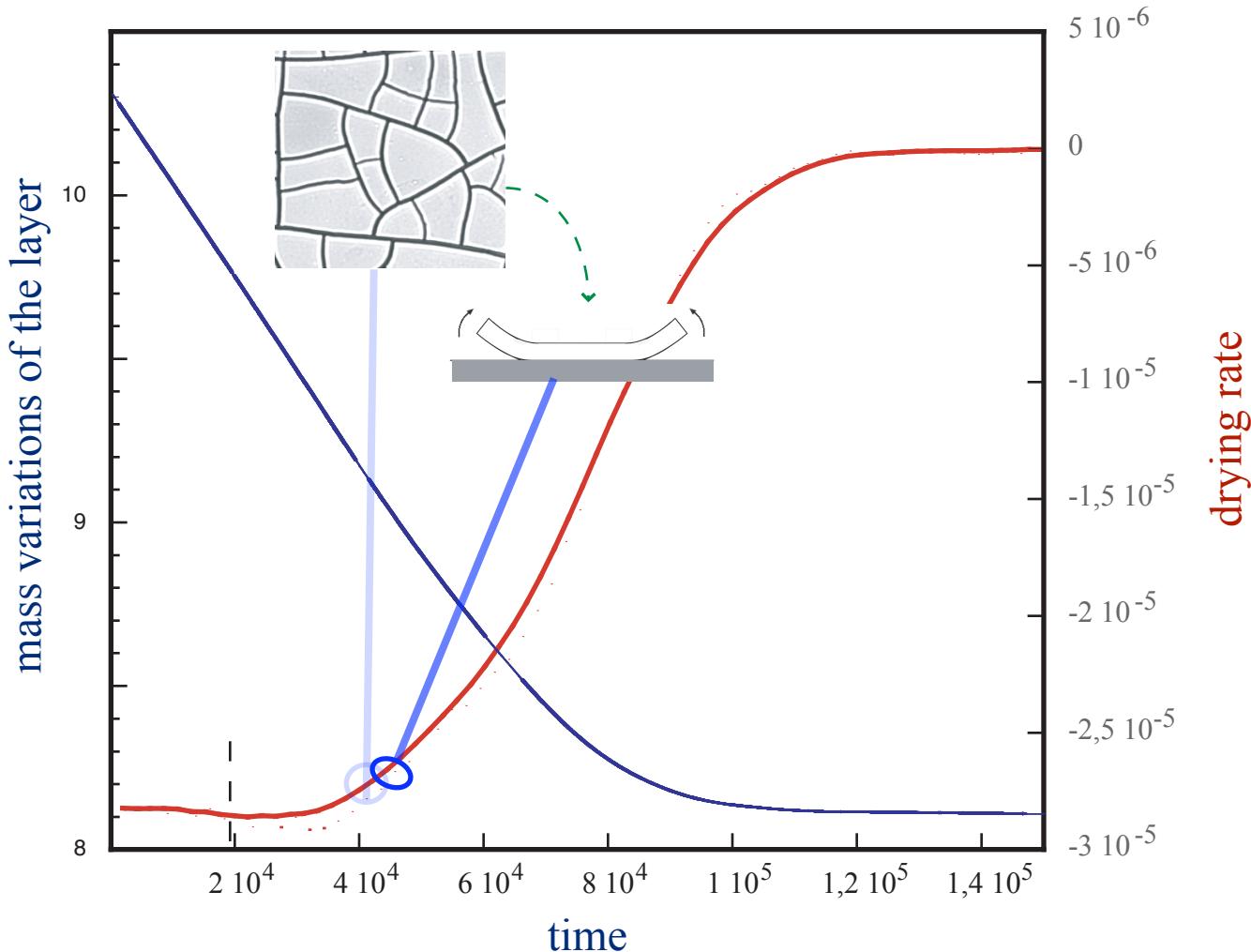


thickness gradient

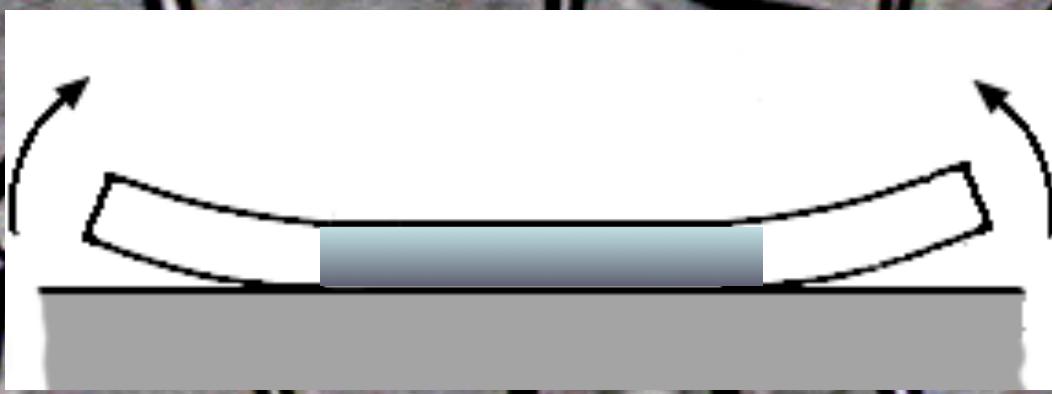
II. fractures
isotropic



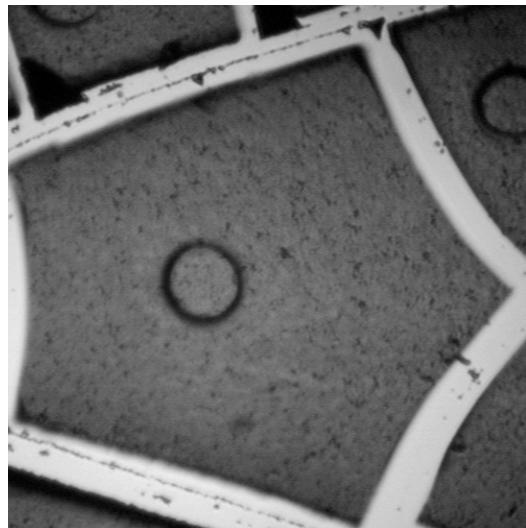
Drying kinetics



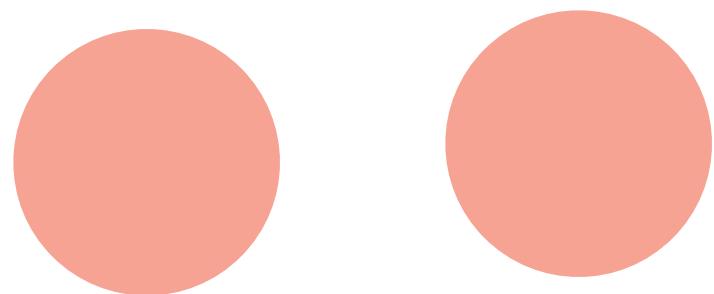
Residual stress



A new generation of cracks inside the adhering region of gel

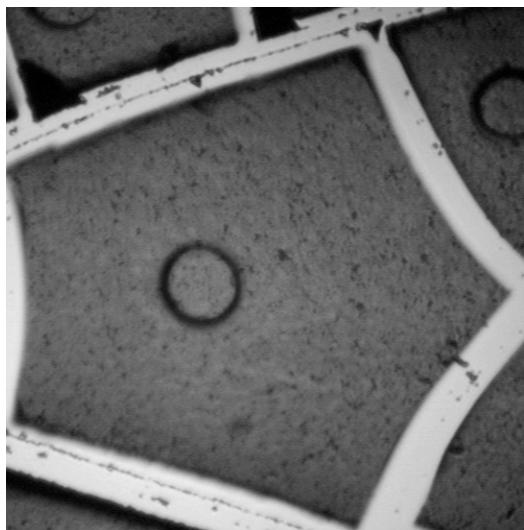


100 μ m



rate ×5

A new generation of cracks inside the adhering region of gel

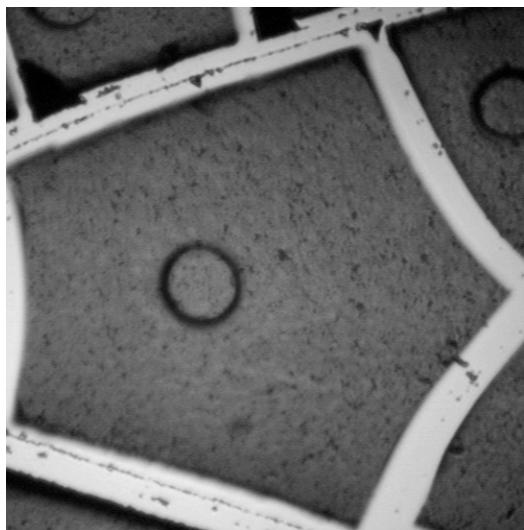


100µm



rate ×5

A new generation of cracks inside the adhering region of gel

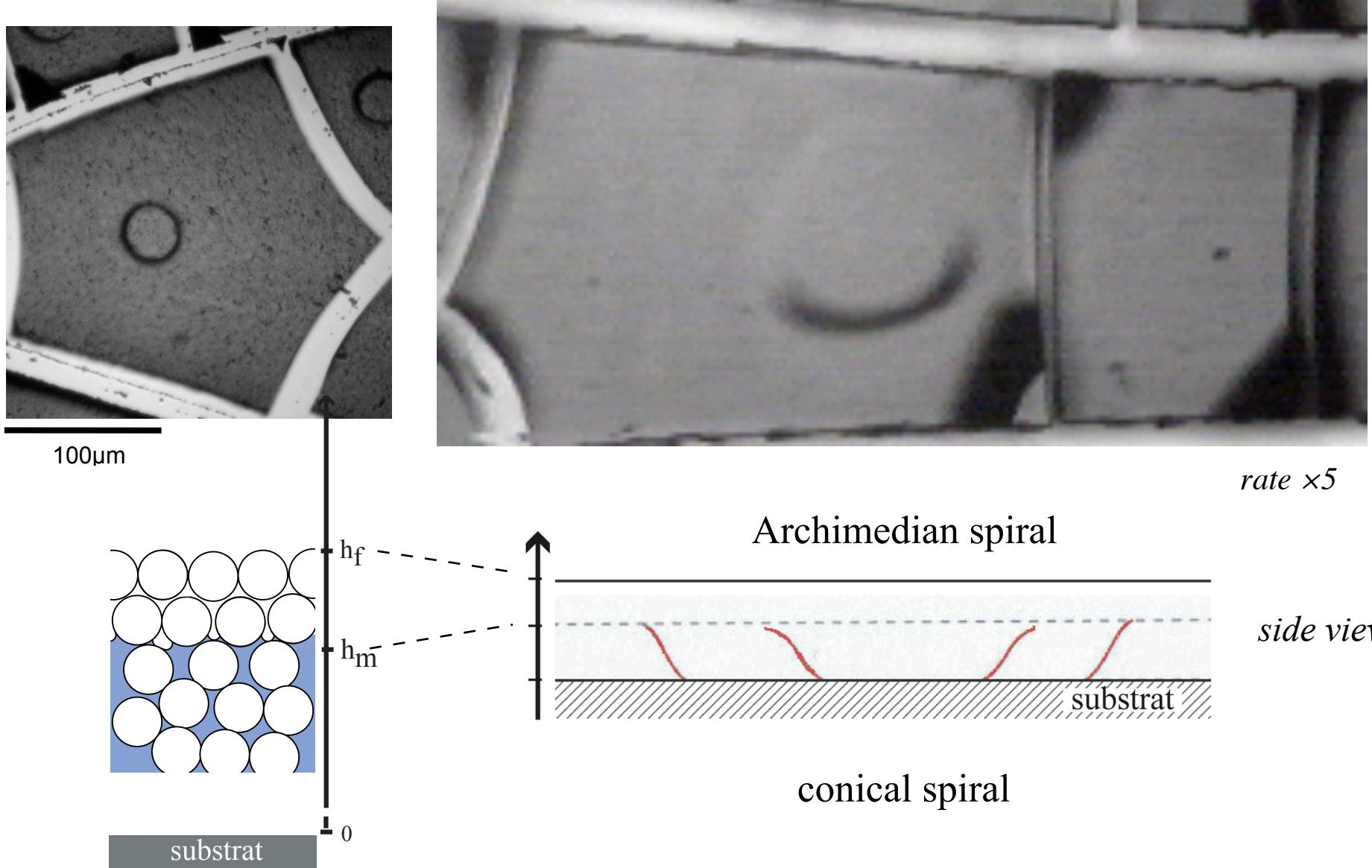


100µm

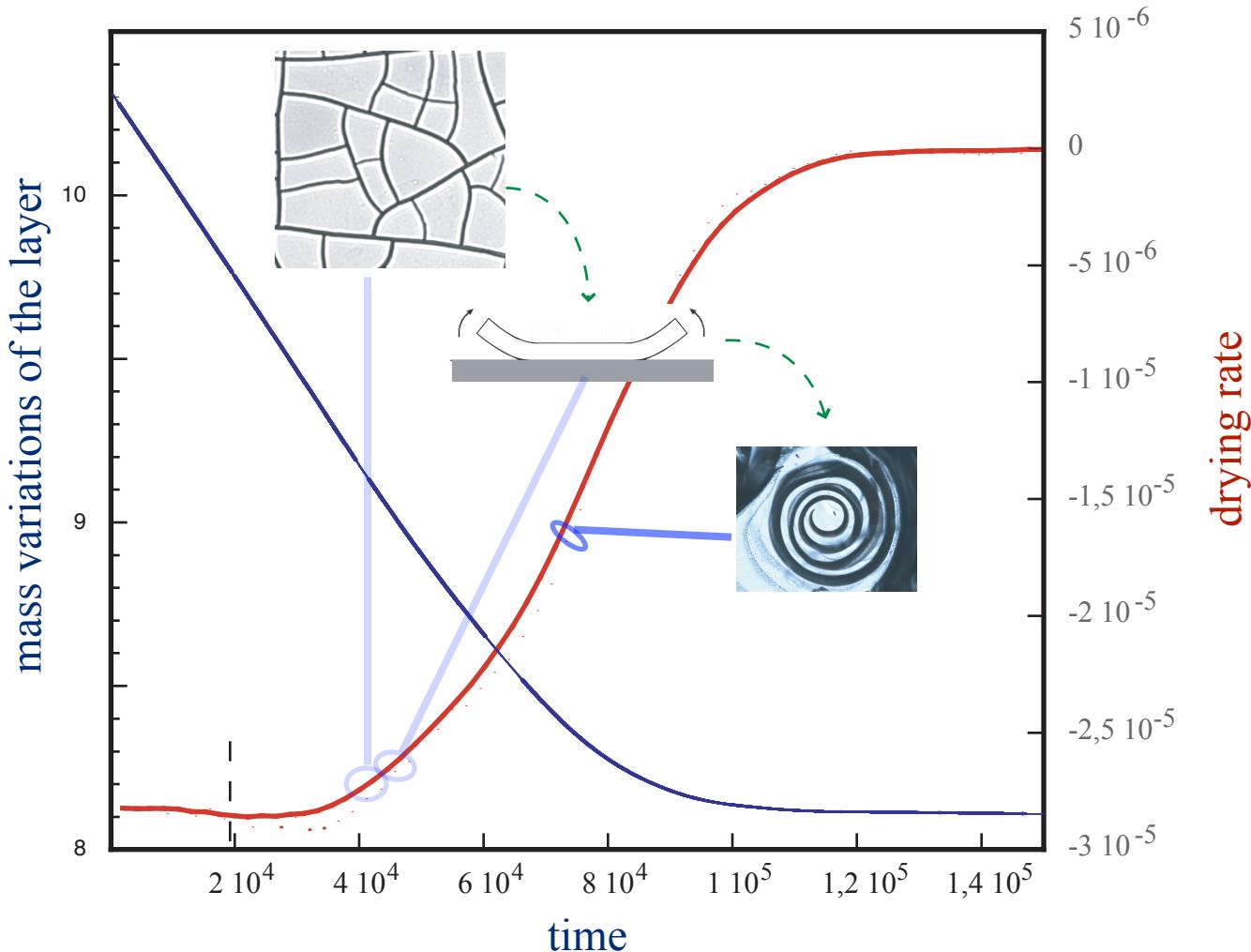


rate ×5

A new generation of cracks inside the adhering region of gel



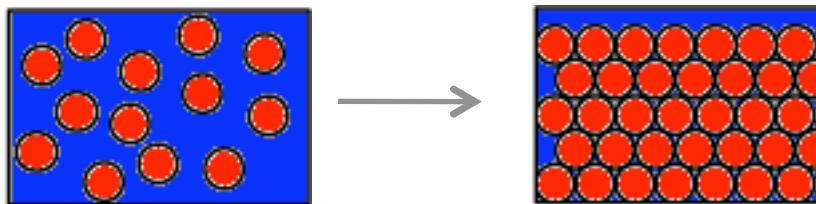
Drying kinetics



Influence of the porous matrix stiffness on the crack patterns

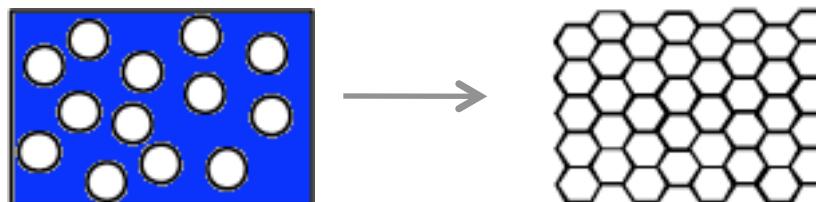
II. fractures
isotropic

Latex particles
suspension of hard particles



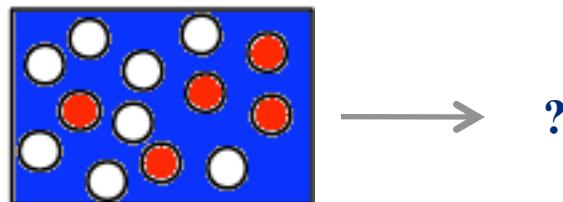
high Tg particles
 $T_{amb} < T_g$

suspension of soft particle

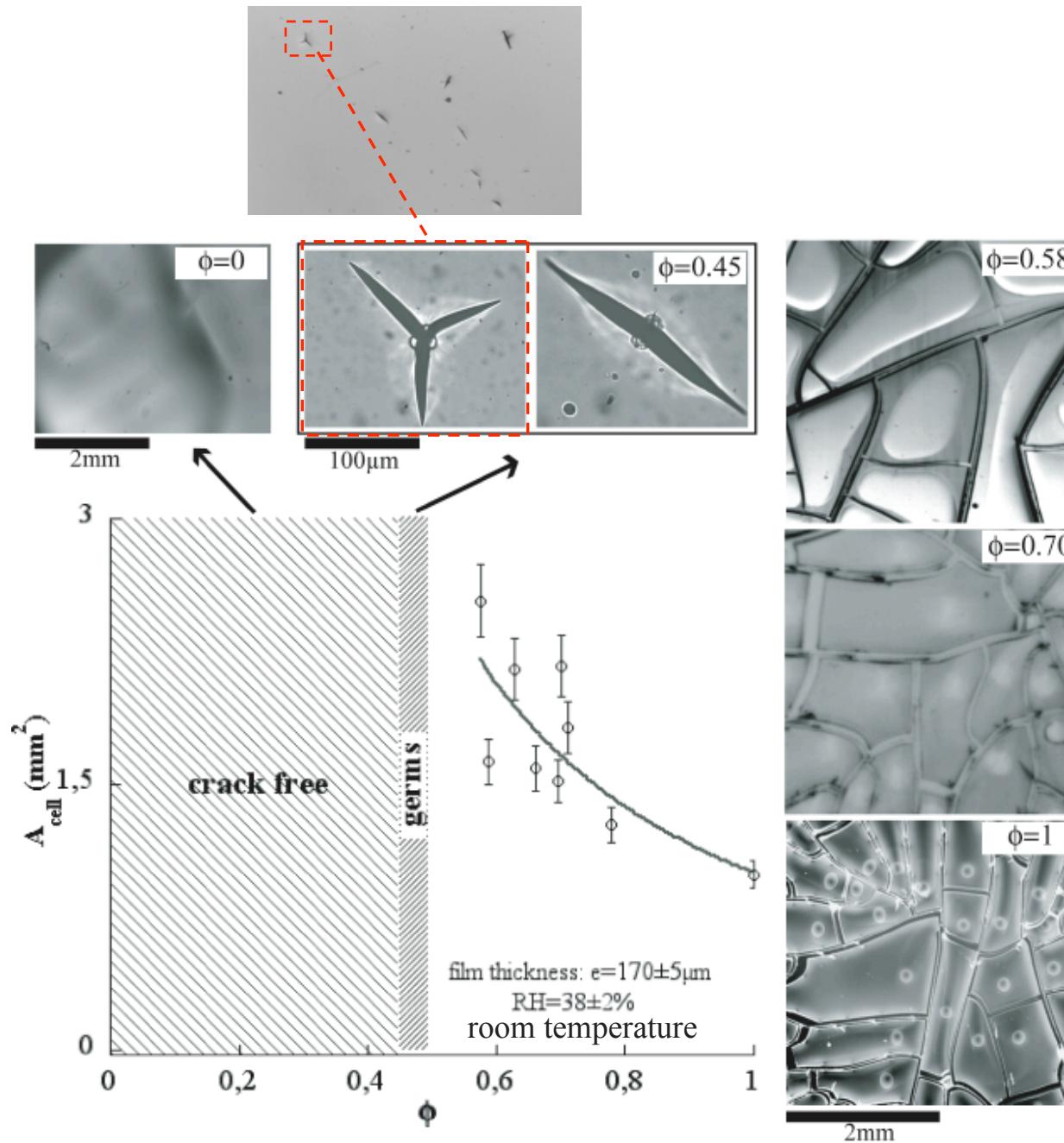


low Tg particles
 $T_g < T_{amb}$

binary mixtures



Influence of the porous matrix stiffness on the crack patterns

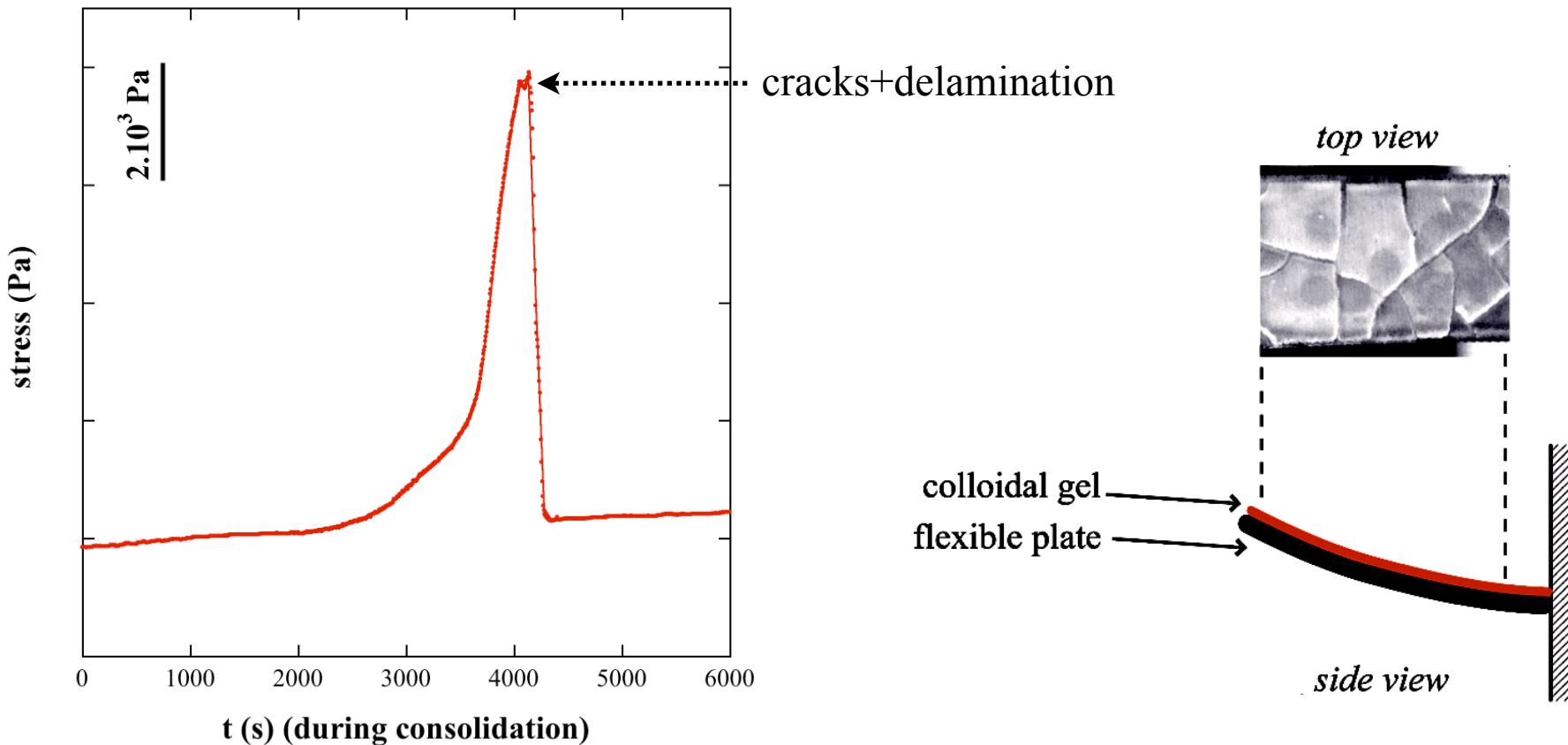


Influence of the porous matrix stiffness on the crack patterns

II. fractures
isotropic

Mechanical characterization of gels made of binary mixtures:

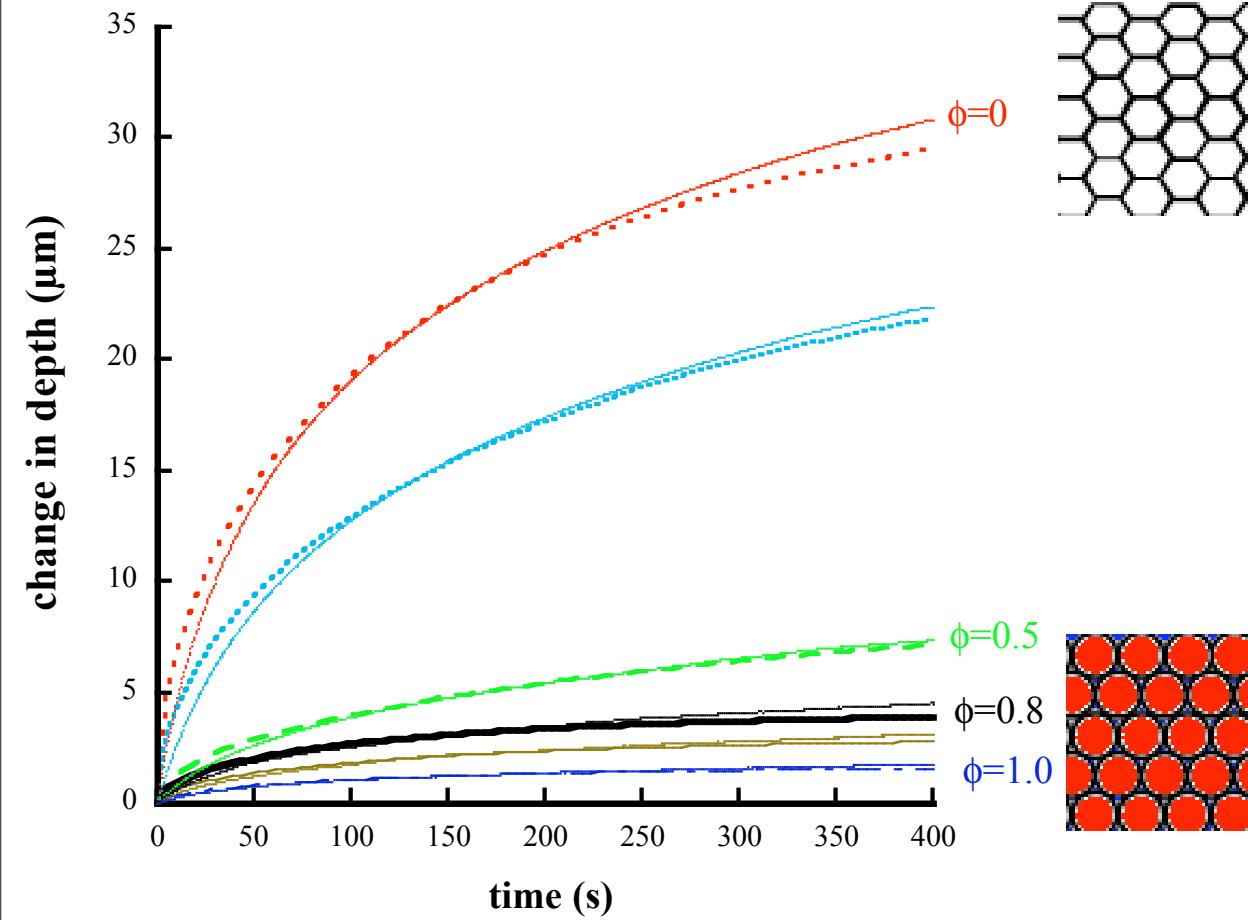
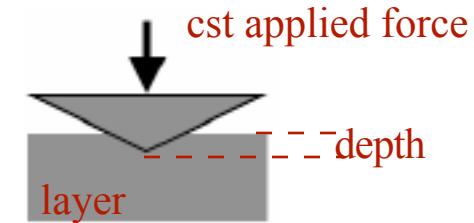
1. mean stress measurements during bending of desiccating gelled layer/flexible plate



Influence of the porous matrix stiffness on the crack patterns

II. fractures
isotropic

Mechanical characterization of gels made of binary mixtures:
2. creep measurements by micro-indentation process

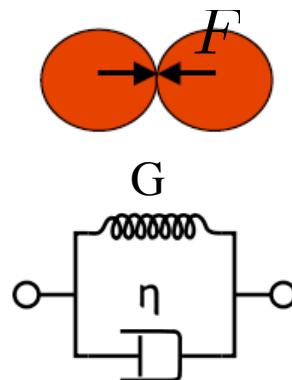


Influence of the porous matrix stiffness on the crack patterns

II. fractures
isotropic

Model for 1D-film formation:

Kelvin-Voigt model



viscoelastic behaviour

$$F \sim -a^2 \left(\frac{G}{2(1-\nu)} + \eta \frac{d}{dt} \right) \epsilon^{3/2}$$

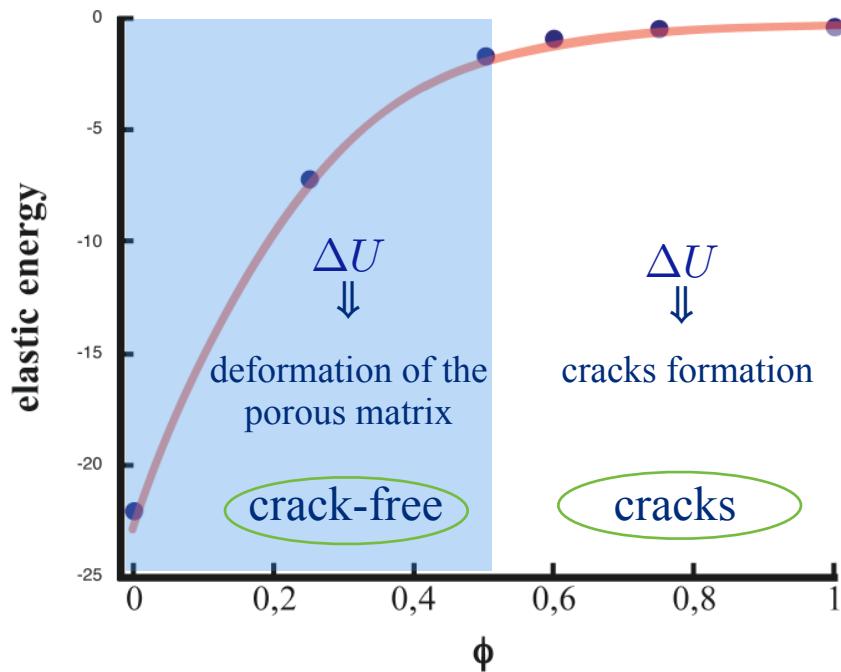
Matthews (1980)

Man, Russel *Phys. Rev. Lett.* (2008)

micro-indentation measurements $\Rightarrow (G, \eta)$

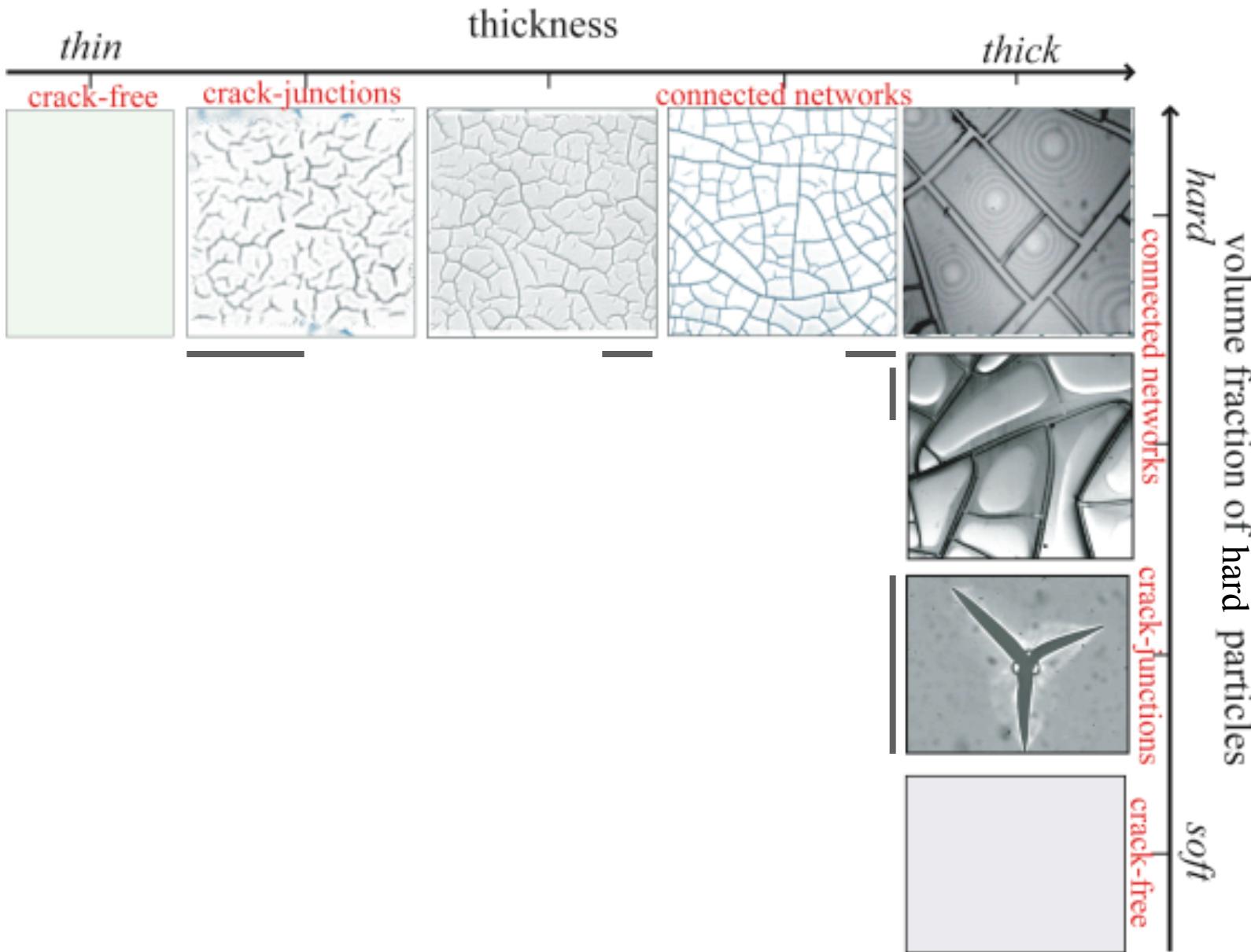
Recovery of elastic energy in the film:

$$\Delta U = \sum_{i,j} \sigma_{ij} \epsilon_{ij}$$



Influence of the layer thickness and porous matrix stiffness on crack patterns

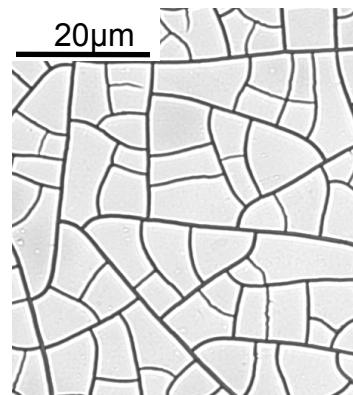
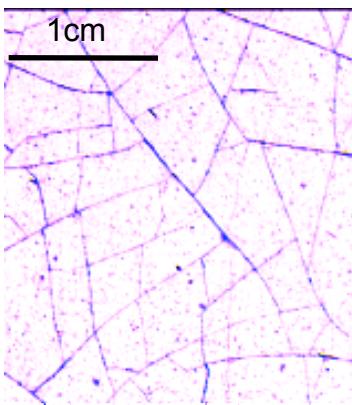
II. fractures
isotropic



series of « les Apôtres »
Georges de La Tour

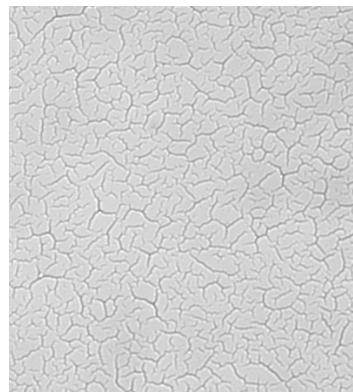
experiments

Craquelures related to the composition of the painting layer



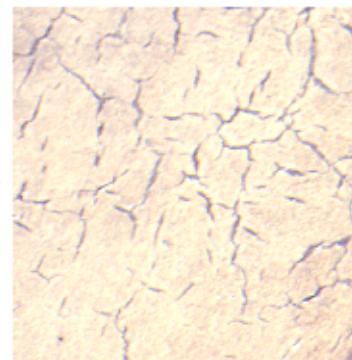
network of connected cracks

*layer thickness~100μm
“rigid” particles*



dense network of isolated cracks

*layer thickness~10μm
“rigid” particles*



low density of isolated cracks



*layer thickness~100μm
“soft” particles*